v02.0312

HMC921LP4E

GaAs HBT MMIC 2 WATT POWER AMPLIFIER, 0.4 - 2.7 GHz

Typical Applications

The HMC921LP4E is ideal for:

- Cellular/3G & WiMAX/LTE/4G
- Fixed Wireless & WLAN
- CATV, Cable Modem & DBS
- Microwave Radio & Test Equipment
- IF & RF Applications

Features

High Output IP3: +48 dBm

High Output P1dB: +33 dBm

High Gain: 16 dB @ 900 MHz

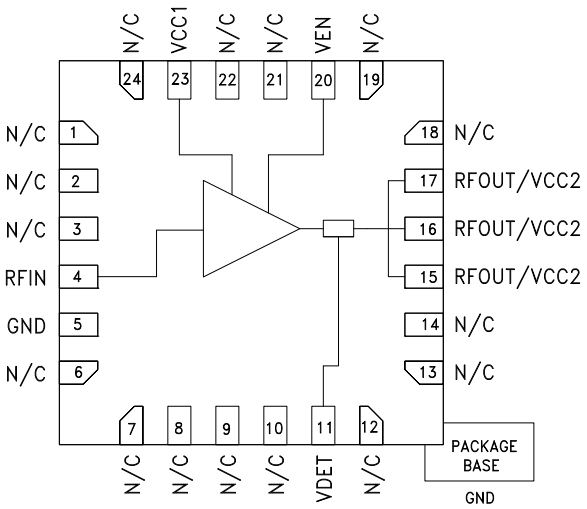
Single Supply: +5V

32% PAE @ +33 dBm Pout

Adjustable Bias Current

24 Lead 4x4 mm SMT Package: 16 mm²

Functional Diagram



General Description

The HMC921LP4E is a high linearity GaAs HBT MMIC 2 watt power amplifier operating from 0.4 to 2.7 GHz and is housed in a RoHS compliant 4x4 mm QFN leadless package. The HMC921LP4E utilizes a minimum number of external components and operates from a single +5V supply. This versatile power amplifier can be biased for both low quiescent current and high quiescent current modes by adjusting a single external resistor.

Electrical Specifications, T_A = +25°C, Vcc1 = Vcc2 = VEN = +5V [1]

Parameter	400 mA (R1 = 270 Ω)															
	Min.	Typ.	Max.	Min.	Typ.	Max.	Min.	Typ.	Max.	Min.	Typ.	Max.	Min.	Typ.	Max.	Units
Frequency Range	350 - 500			800 - 1000			1800 - 2000			2000 - 2200			2500 - 2800			MHz
Gain	17	19		14	16		9	11		9.5	10.5		8	9		dB
Gain Variation Over Temperature		0.01			0.01			0.01			0.01			0.01		dB / °C
Input Return Loss	9	12		10	15		5	10		8	12		6	11		dB
Output Return Loss	6	10		5	9		8	9		6	7		9	10		dB
Output Power for 1dB Compression (P1dB)	32.5	34		30.5	32		31	32.5		32	32.5		33	33.3		dBm
Saturated Output Power (Psat)		35			34			34			34			34.5		dBm
Output Third Order Intercept (IP3)		47			44			43			43			45		dBm
Noise Figure		12.9			9			8.5			6.9			6.5		dB
Supply Current (Icq) Ien Icc1 Icc2		8 12 400			8 12 400			8 12 400			8 12 400			8 12 400		mA mA mA

[1] Specifications and data reflect HMC921LP4E measured using the respective application circuits for each designated frequency band found herein. Contact the HMC Applications Group for assistance in optimizing performance for your application.

GaAs HBT MMIC 2 WATT POWER AMPLIFIER, 0.4 - 2.7 GHz

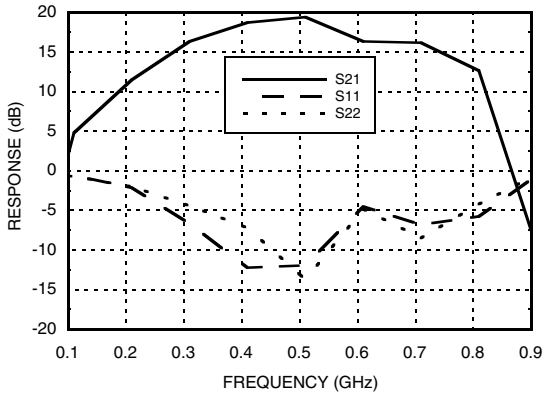
Electrical Specifications, T_A = +25°C, Vcc1 = Vcc2 = VEN = +5V [1]

Parameter	700 mA (R1 = 130 Ω)															
	Min.	Typ.	Max.	Min.	Typ.	Max.	Min.	Typ.	Max.	Min.	Typ.	Max.	Min.	Typ.	Max.	Units
Frequency Range	350 - 500			800 - 1000			1800 - 2000			2000 - 2200			2600 - 2800			MHz
Gain	19	19.5		14	16		9	11		10.3	10.8		8	9		dB
Gain Variation Over Temperature		001			0.01			0.01			0.01			0.01		dB / °C
Input Return Loss	9	12		11	15		6	10		9	13		6	12		dB
Output Return Loss	6	10		6	9		8	9		6	7.5		9	10		dB
Output Power for 1dB Compression (P1dB)	33	34.5		31	32.5		31.5	33		32.8	33.5		33	34		dBm
Saturated Output Power (Psat)		35			34			34			34.5			35		dBm
Output Third Order Intercept (IP3)		43			45			46			47			47		dBm
Noise Figure		14			9			8.5			8			8		dB
Supply Current (Icq) Ien		13			13			13			13			13		mA
Icc1		14			14			14			14			14		mA
Icc2		700			700			700			700			700		mA

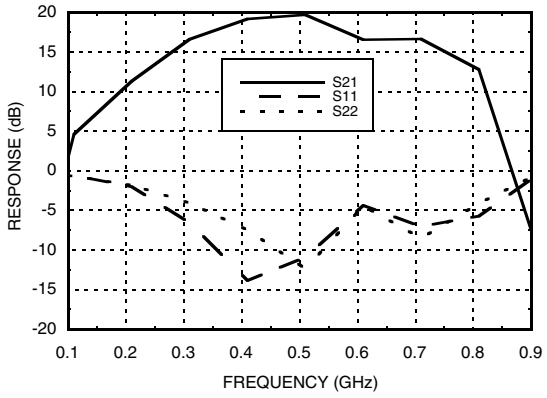
[1] Specifications and data reflect HMC921LP4E measured using the respective application circuits for each designated frequency band found herein. Contact the HMC Applications Group for assistance in optimizing performance for your application.

450 MHz Tune

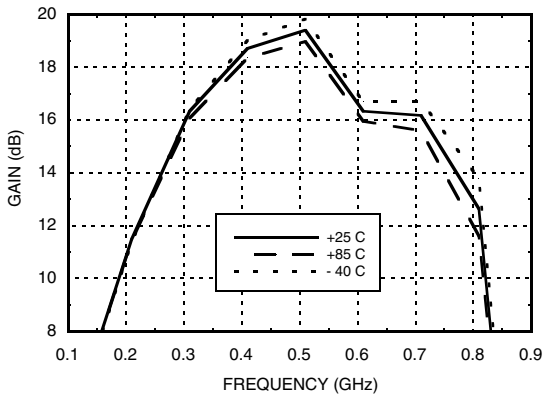
Broadband Gain & Return Loss @ 400mA



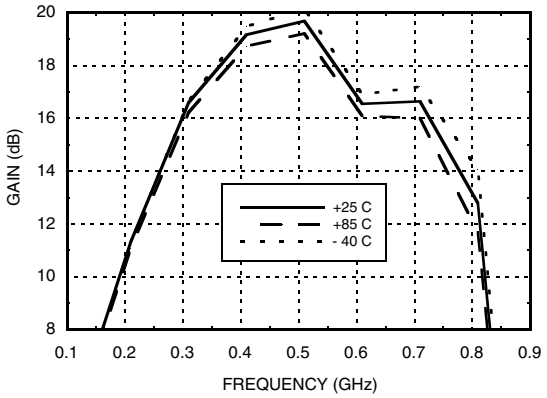
Broadband Gain & Return Loss @ 700mA



Gain vs. Temperature @ 400mA



Gain vs. Temperature @ 700mA

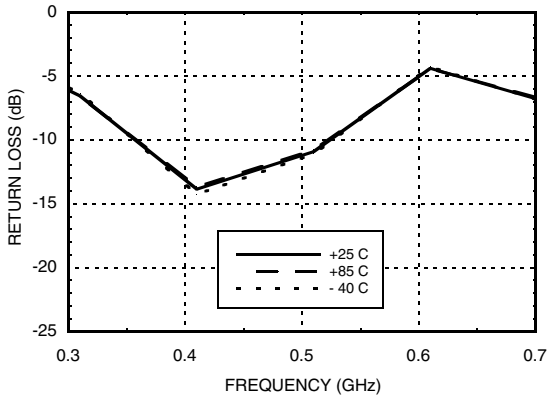


HMC921LP4E

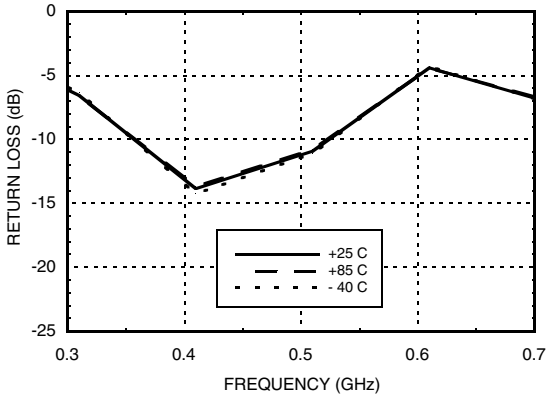
GaAs HBT MMIC 2 WATT POWER AMPLIFIER, 0.4 - 2.7 GHz

450 MHz Tune

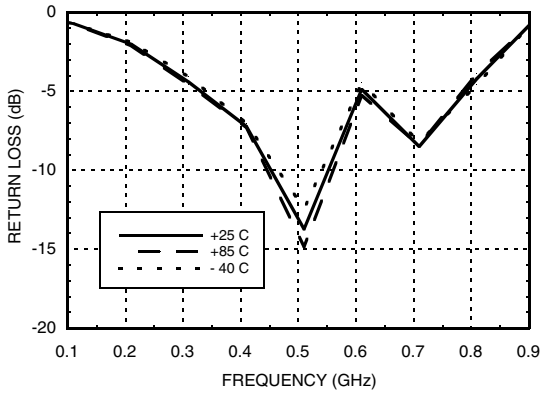
Input Return Loss @ 400 mA



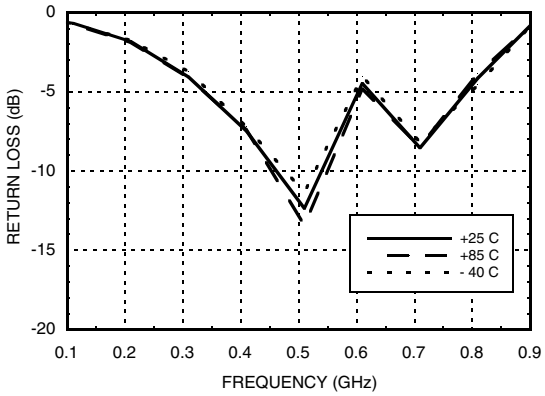
Input Return Loss @ 700 mA



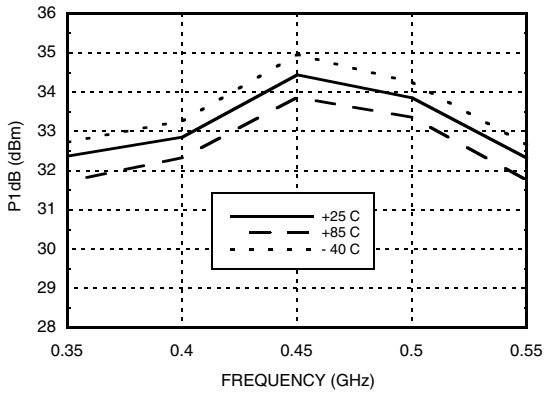
Output return Loss @ 400 mA



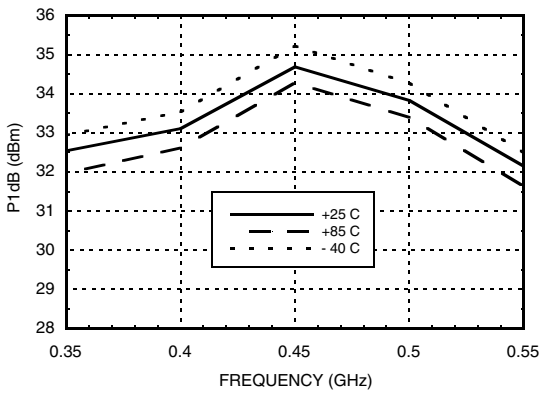
Output return Loss @ 700 mA



P1dB vs. Temperature @ 400 mA

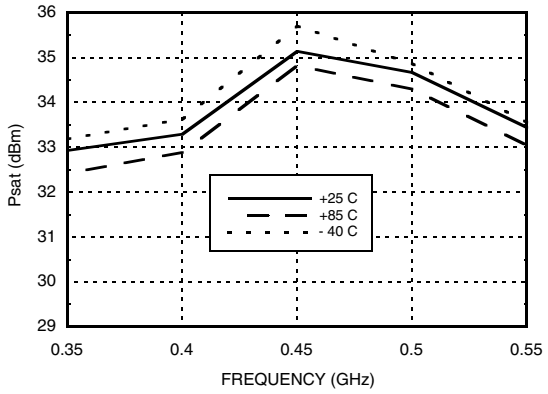


P1dB vs. Temperature @ 700 mA

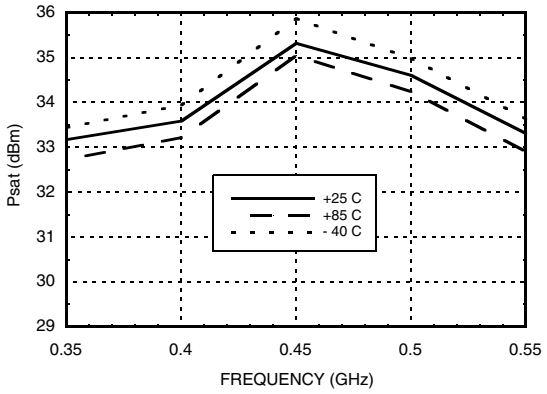


450 MHz Tune

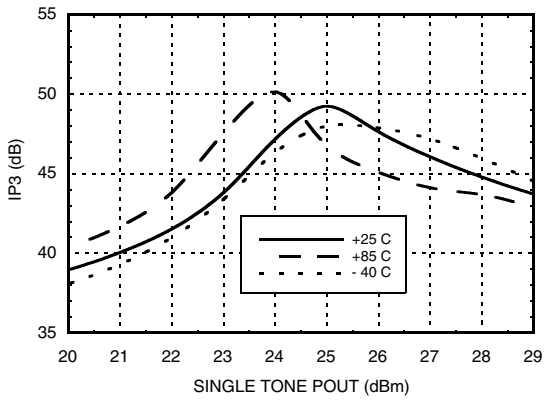
Psat vs. Temperature @ 400mA



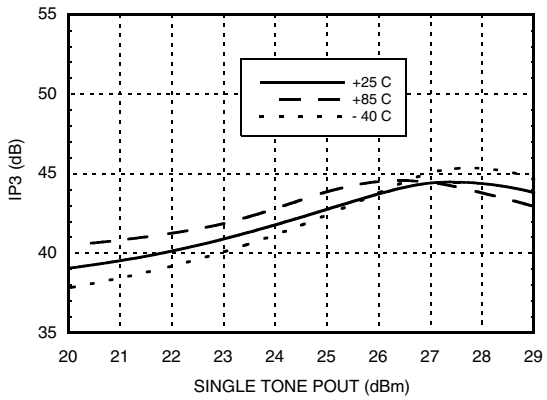
Psat vs. Temperature @ 700mA



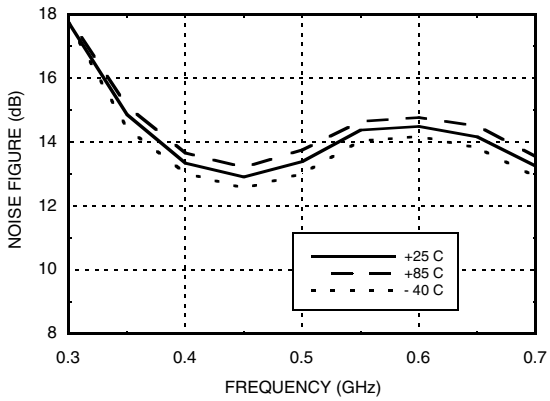
Output IP3 vs. Output Power @ 400mA



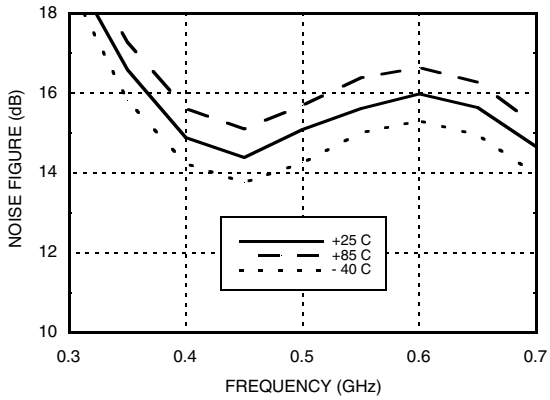
Output IP3 vs. Output Power @ 700mA



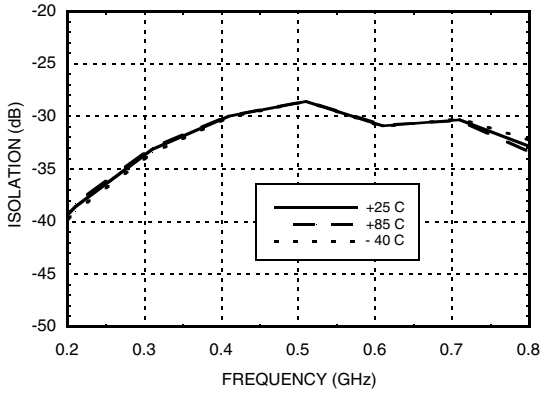
Noise Figure vs. Temperature @ 400mA



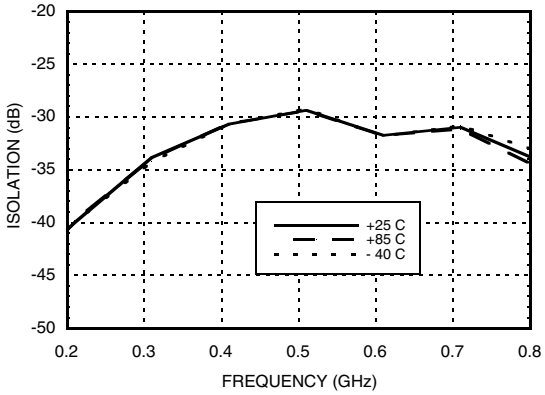
Noise Figure vs. Temperature @ 700mA



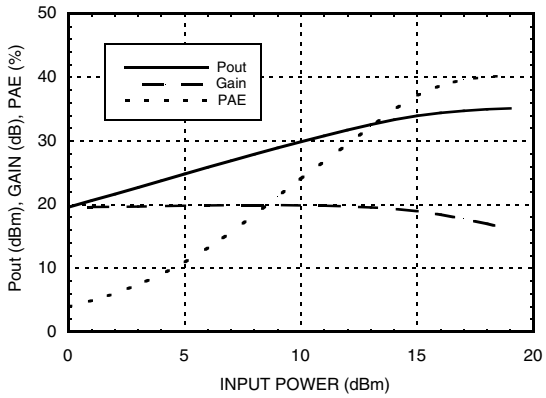
Reverse Isolation vs. Temperature 400mA



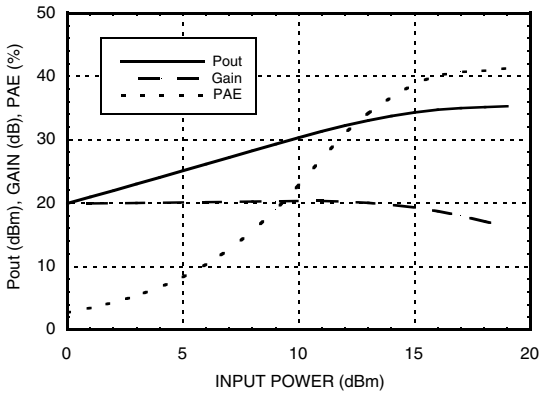
Reverse Isolation vs. Temperature 700mA



Power Compression @ 400mA



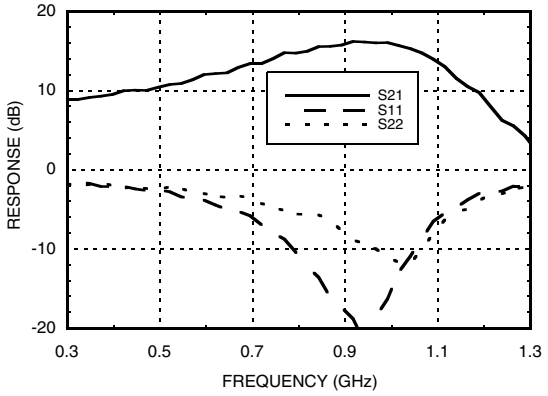
Power Compression @ 700mA



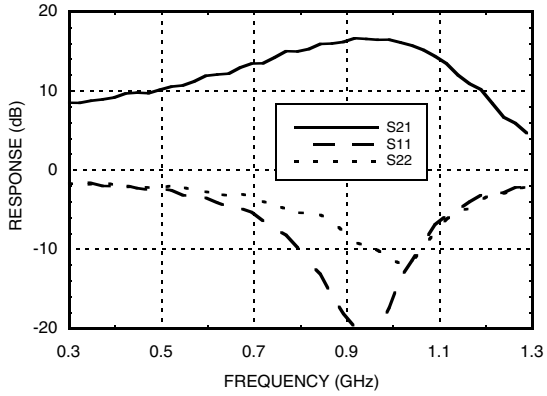
GaAs HBT MMIC 2 WATT POWER AMPLIFIER, 0.4 - 2.7 GHz

900 MHz Tune

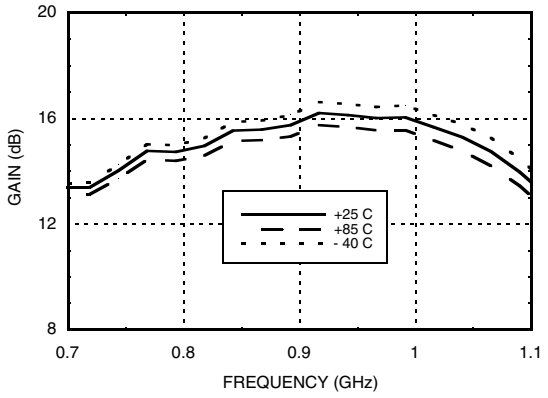
Broadband Gain & Return Loss @ 400 mA



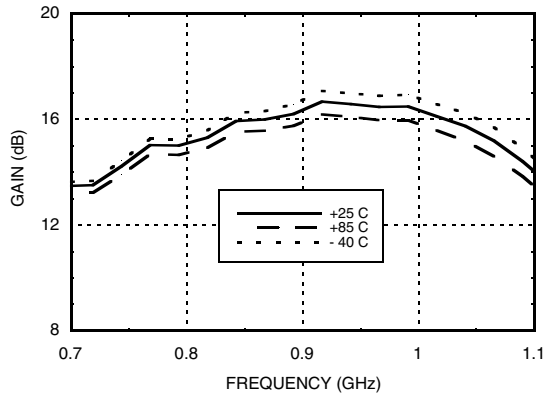
Broadband Gain & Return Loss @ 700 mA



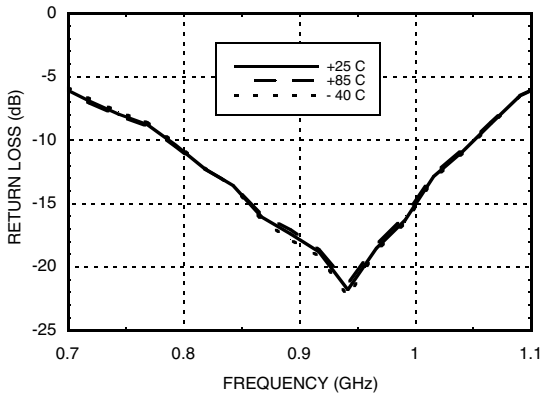
Gain vs. Temperature @ 400 mA



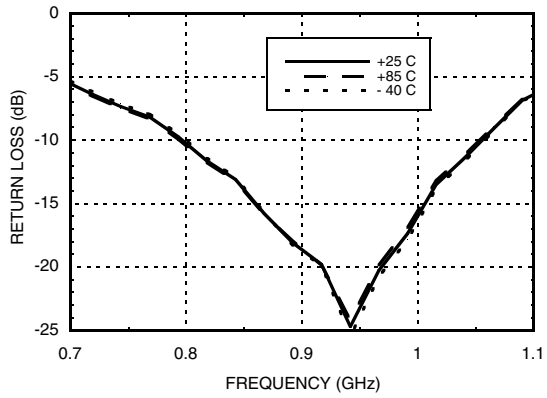
Gain vs. Temperature @ 700 mA



Input Return Loss vs. Temperature 400mA

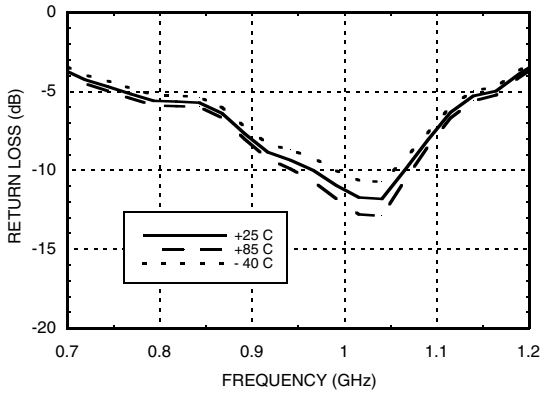


Input Return Loss vs. Temperature 700mA

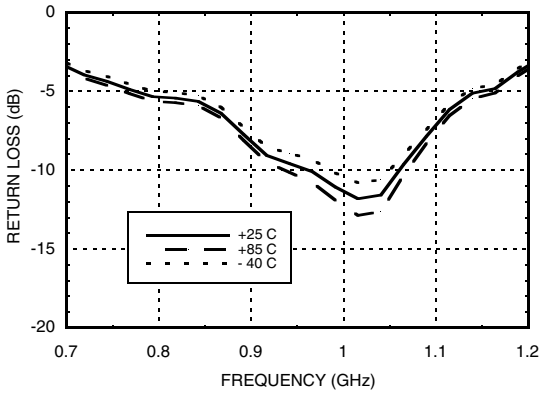


900 MHz Tune

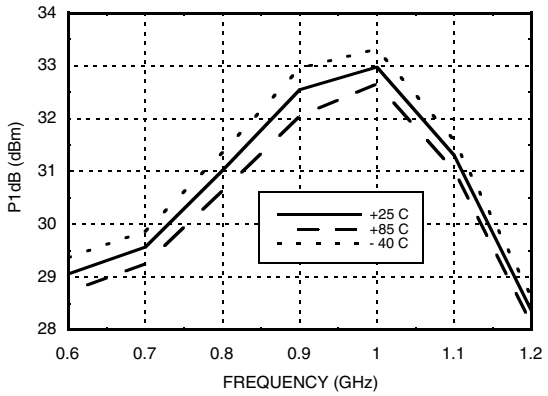
Output Return Loss @ 400mA



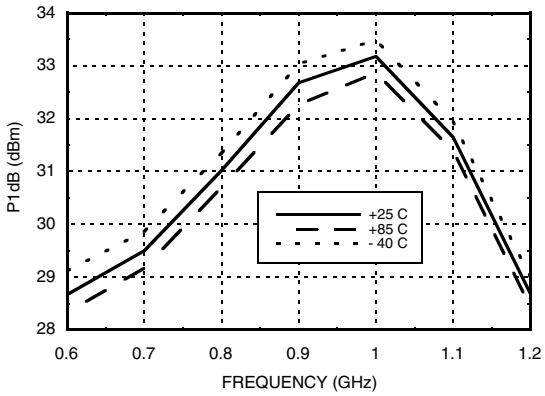
Output Return Loss @ 700mA



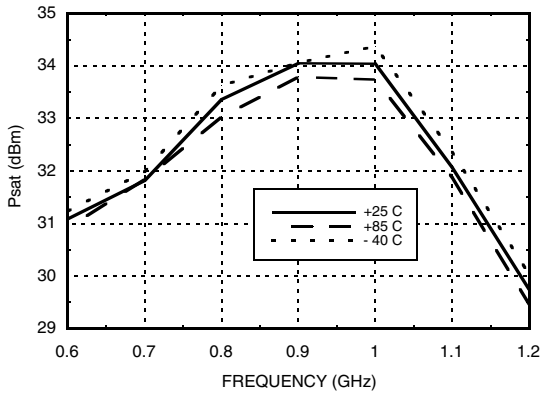
P1dB vs. Temperature @ 400 mA



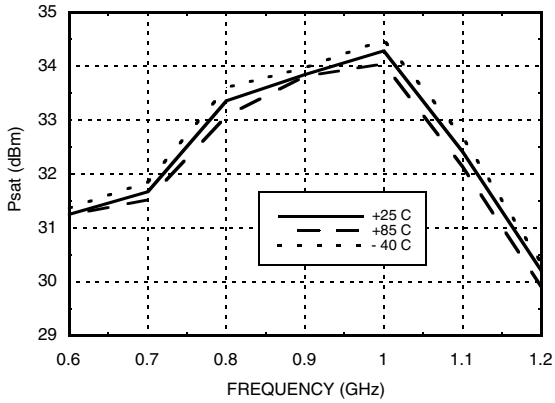
P1dB vs. Temperature @ 700 mA



Psat vs. Temperature @ 400 mA



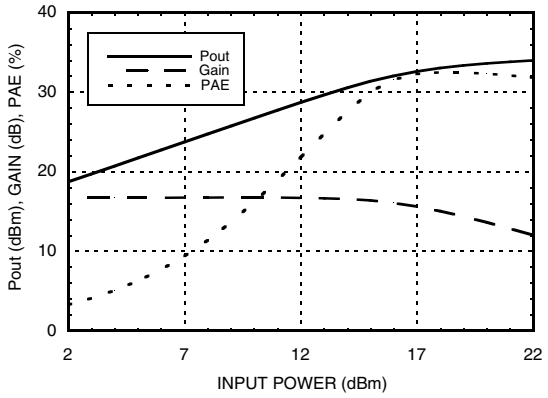
Psat vs. Temperature @ 700 mA



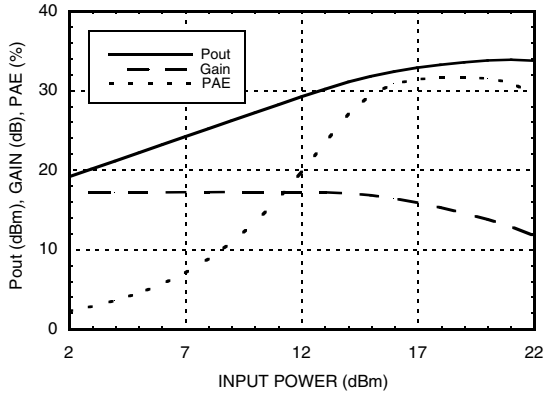
GaAs HBT MMIC 2 WATT POWER AMPLIFIER, 0.4 - 2.7 GHz

900 MHz Tune

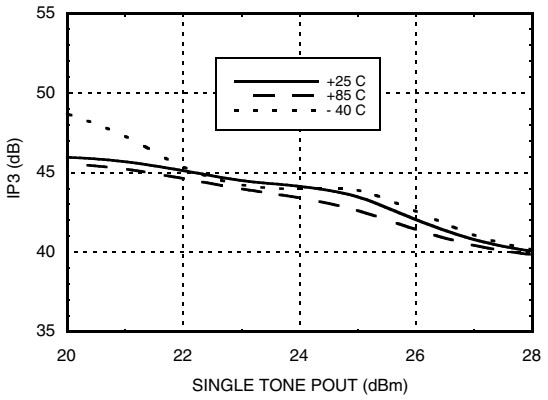
Power Compression @ 400 mA



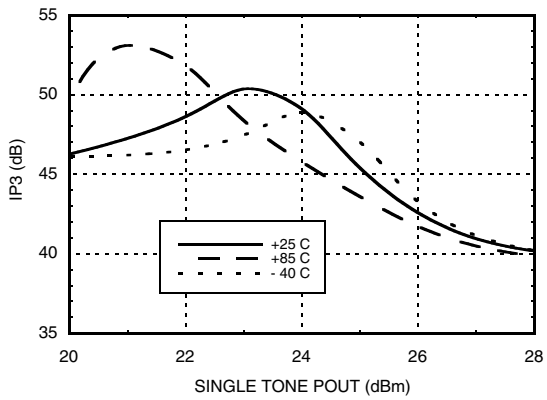
Power Compression @ 700 mA



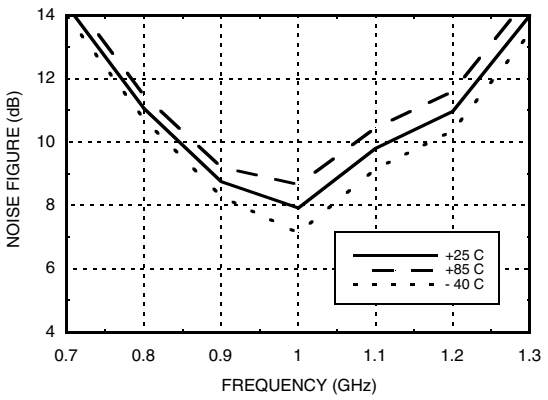
Output IP3 vs. Output Power @ 400 mA



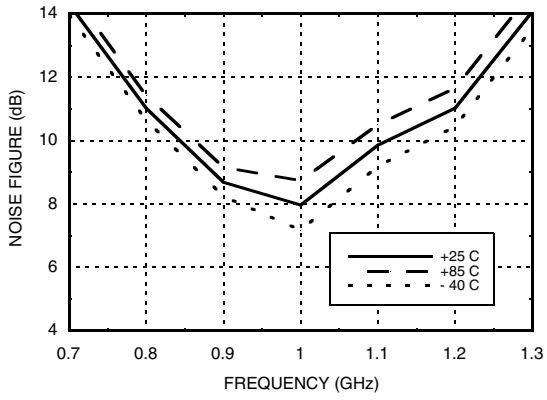
Output IP3 vs. Output Power @ 700 mA



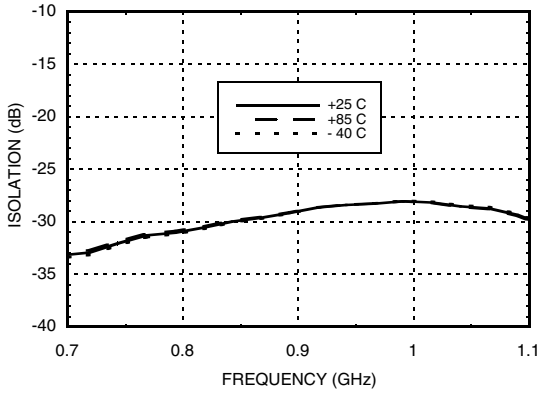
Noise Figure vs. Temperature 400 mA



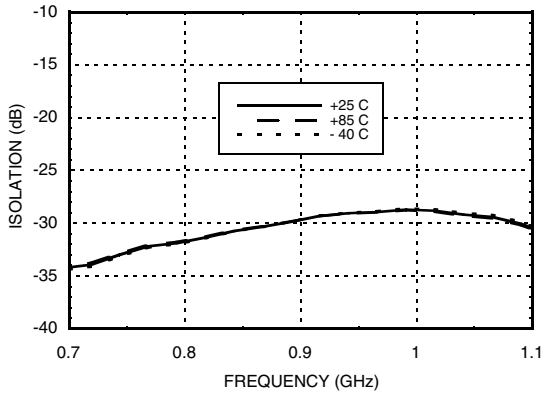
Noise Figure vs. Temperature 700 mA



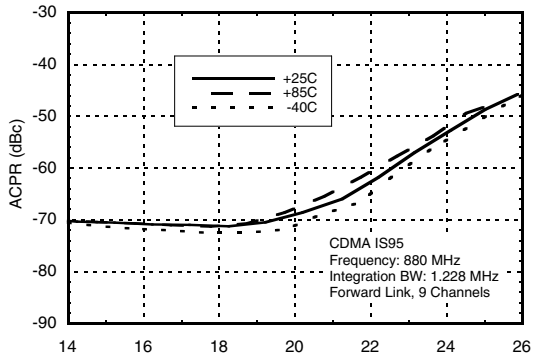
Reverse Isolation vs. Temperature 400mA



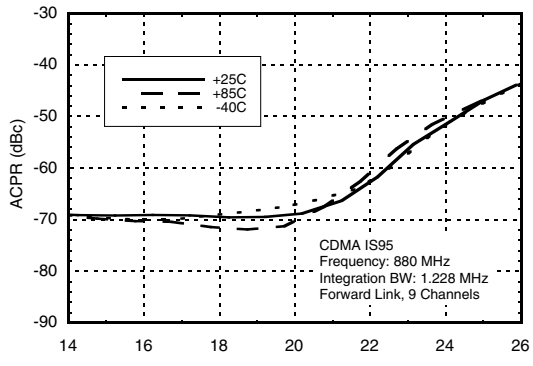
Reverse Isolation vs. Temperature 700mA



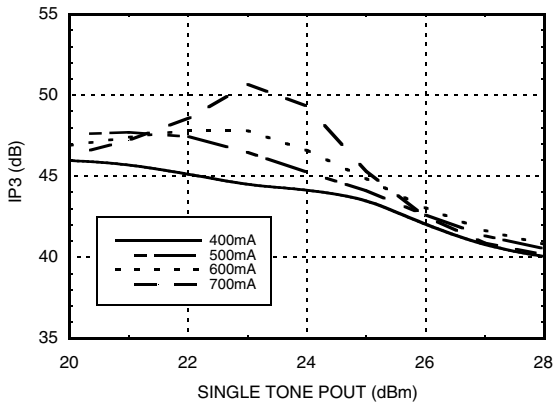
ACPR vs. Temperature @ 880 MHz CDMA 2000, 9 Channels Forward, 400 mA



ACPR vs. Temperature @ 880 MHz CDMA 2000, 9 Channels Forward, 700 mA



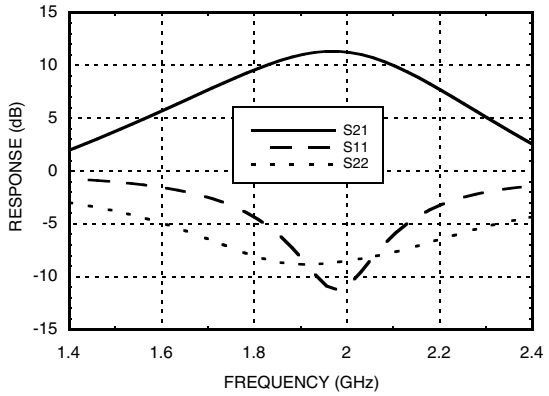
Output IP3 vs. Bias Current



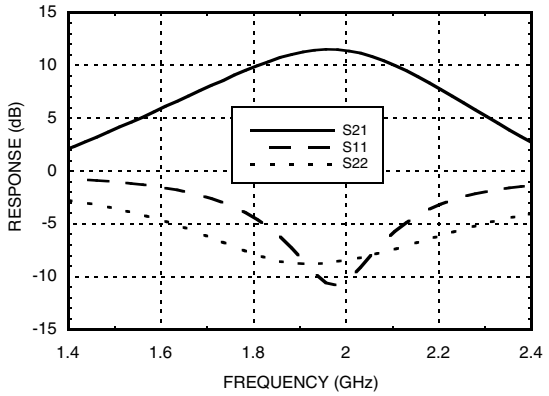
GaAs HBT MMIC 2 WATT POWER AMPLIFIER, 0.4 - 2.7 GHz

1900 MHz Tune

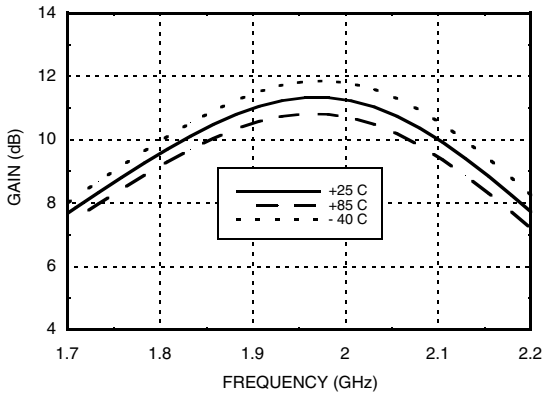
Broadband Gain & Return Loss @ 400 mA



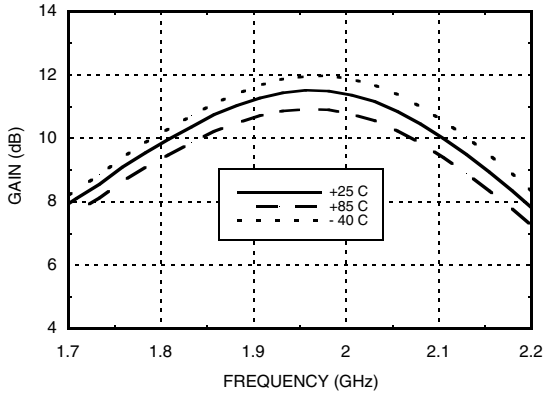
Broadband Gain & Return Loss @ 700 mA



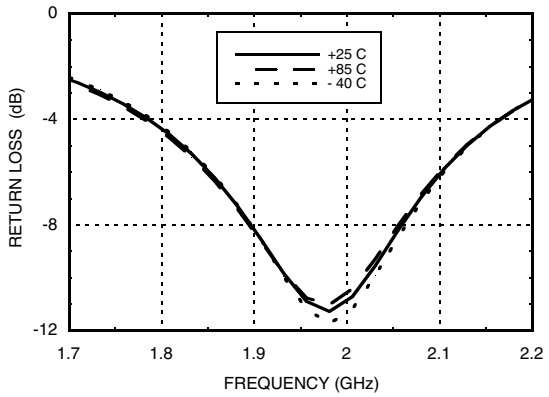
Gain vs. Temperature @ 400 mA



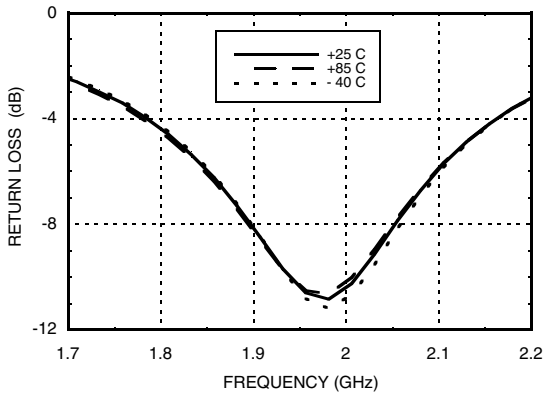
Gain vs. Temperature @ 700 mA



Input Return Loss @ 400 mA



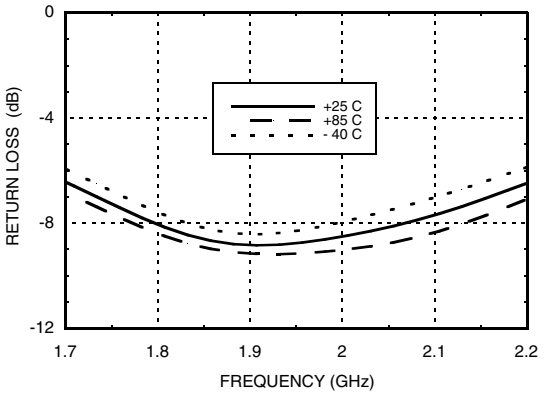
Input Return Loss @ 700 mA



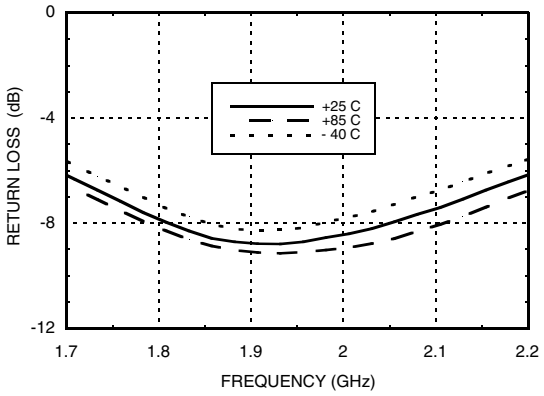
GaAs HBT MMIC 2 WATT POWER AMPLIFIER, 0.4 - 2.7 GHz

1900 MHz Tune

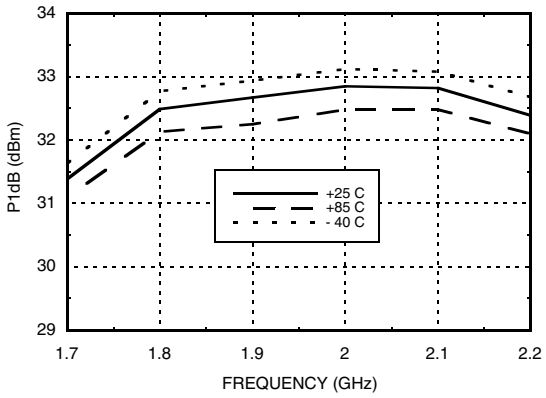
Output Return Loss @ 400 mA



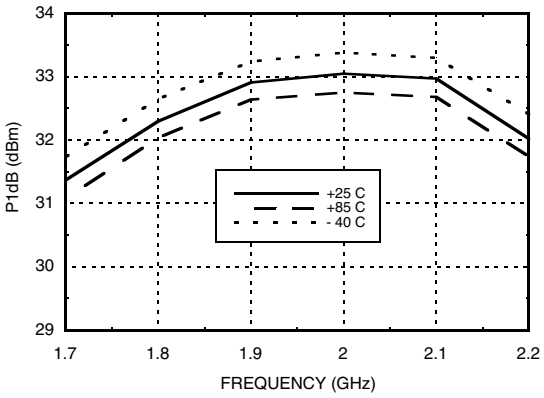
Output Return Loss @ 700 mA



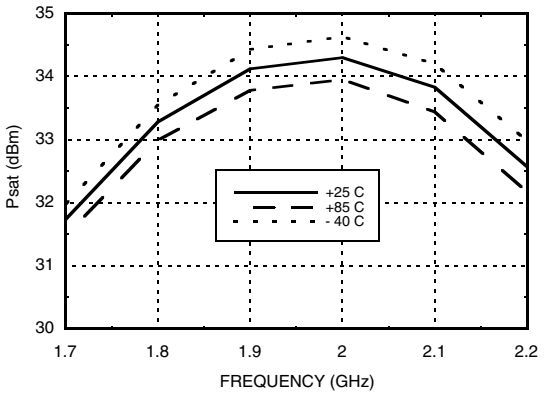
P1dB vs. Temperature @ 400 mA



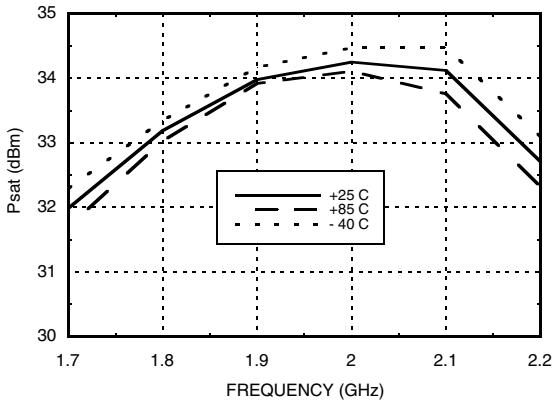
P1dB vs. Temperature @ 700 mA



Psat vs. Temperature @ 400 mA



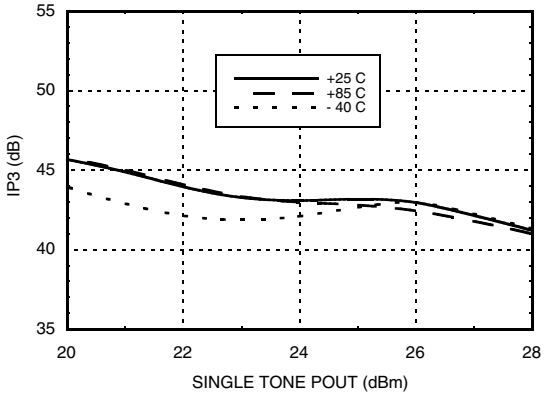
Psat vs. Temperature @ 700 mA



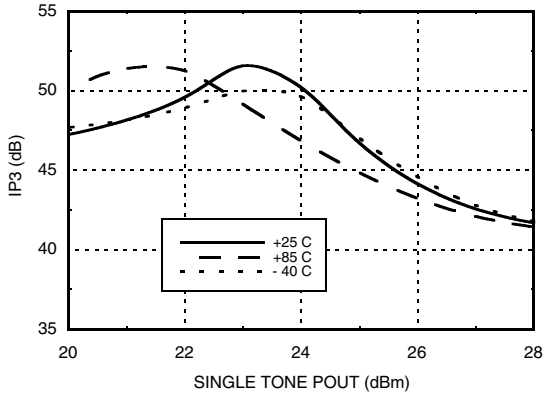
GaAs HBT MMIC 2 WATT POWER AMPLIFIER, 0.4 - 2.7 GHz

1900 MHz Tune

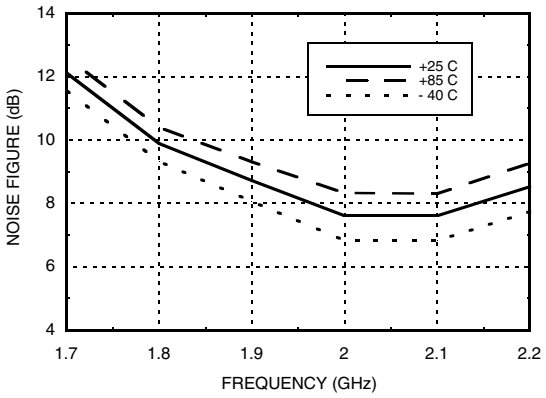
Output IP3 vs. Output Power @ 400 mA



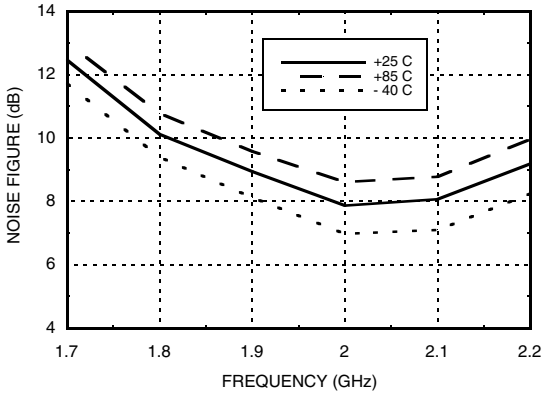
Output IP3 vs. Output Power @ 700 mA



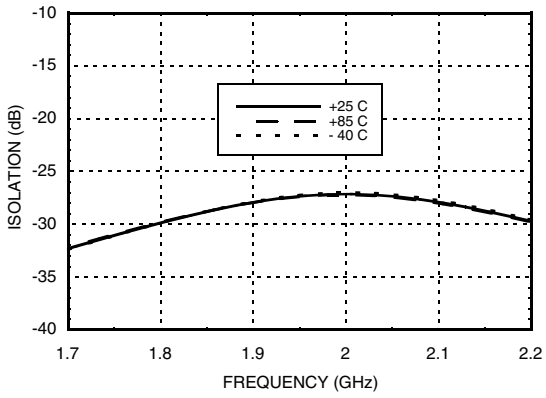
Noise Figure vs. Temperature @ 400 mA



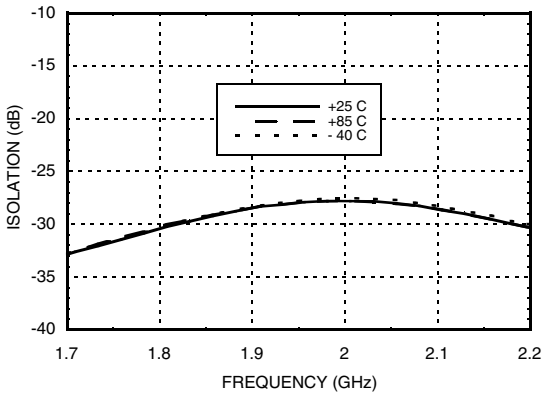
Noise Figure vs. Temperature @ 700 mA



Reverse Isolation vs. Temperature 400 mA



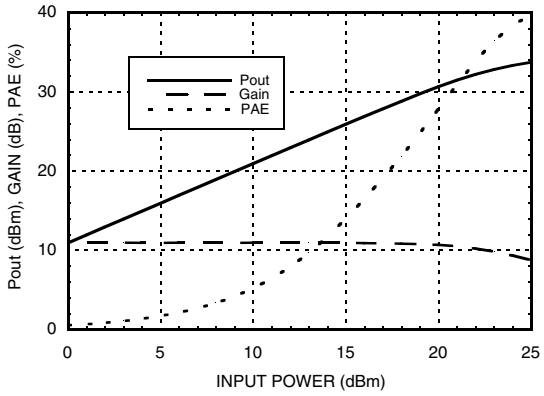
Reverse Isolation vs. Temperature 700 mA



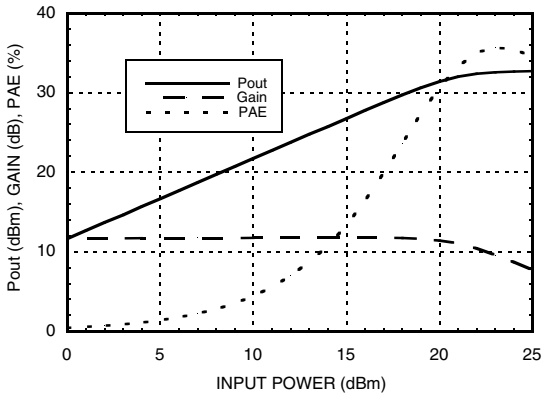
GaAs HBT MMIC 2 WATT POWER AMPLIFIER, 0.4 - 2.7 GHz

1900 MHz Tune

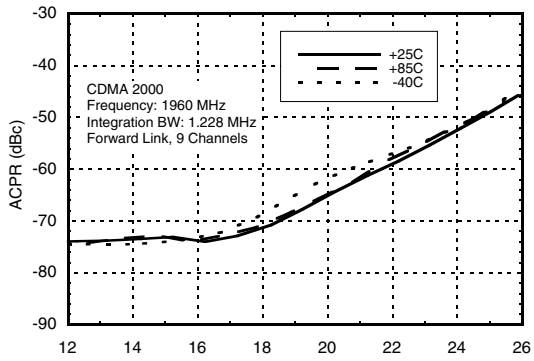
Power Compression @ 400 mA



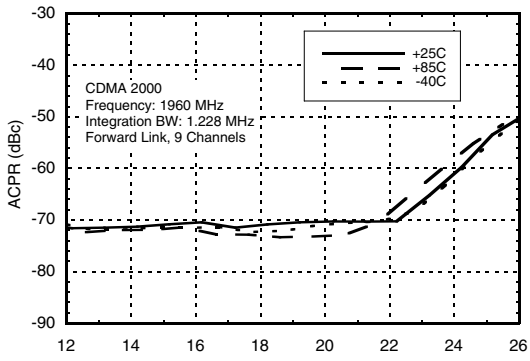
Power Compression @ 700 mA



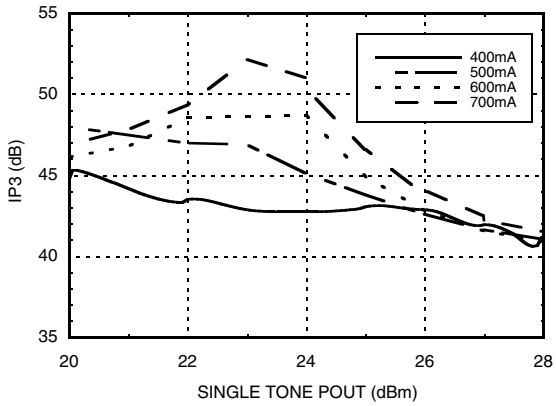
ACPR vs. Temperature @ 1960 MHz CDMA 2000, 9 Channels Forward, 400 mA



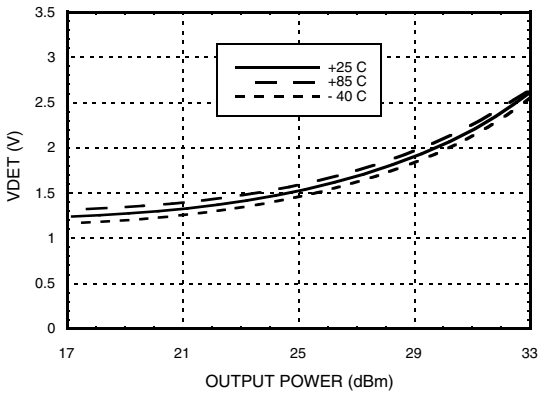
ACPR vs. Temperature @ 1960 MHz CDMA 2000, 9 Channels Forward, 700 mA



Output IP3 vs. Bias Current



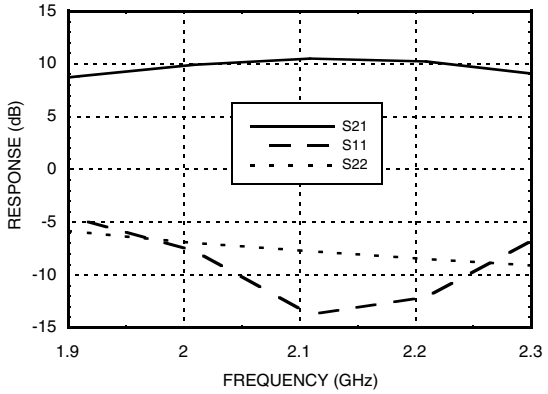
VDET Output Voltage vs. Temperature



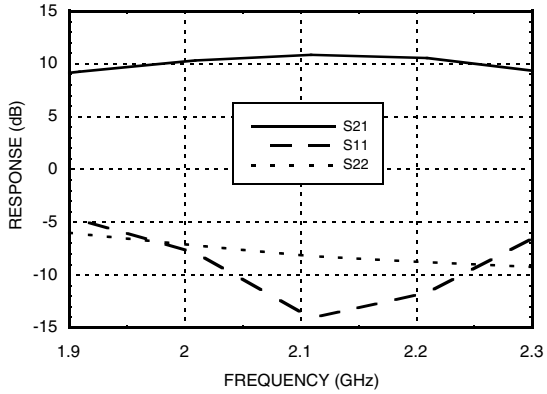
GaAs HBT MMIC 2 WATT POWER AMPLIFIER, 0.4 - 2.7 GHz

2150 MHz Tune

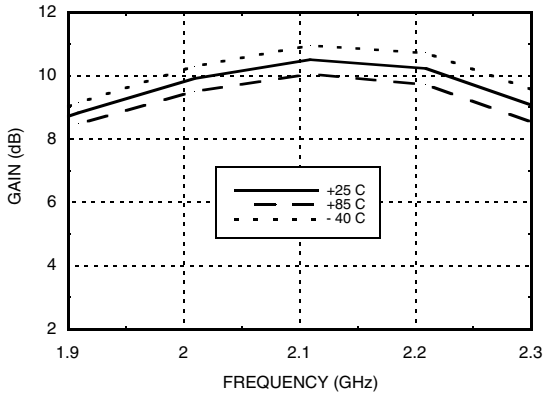
Broadband Gain & Return Loss @ 400 mA



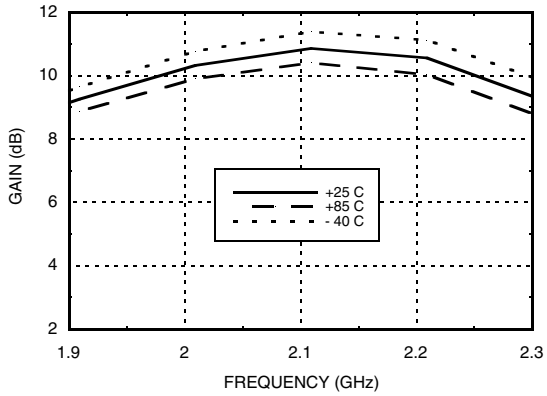
Broadband Gain & Return Loss @ 700 mA



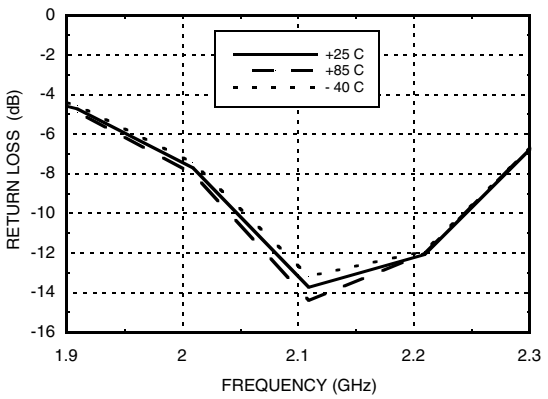
Gain vs. Temperature @ 400 mA



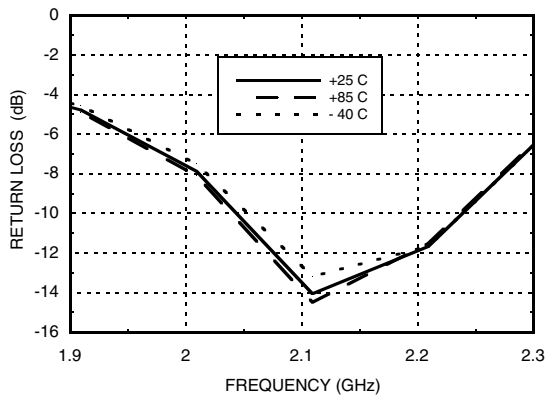
Gain vs. Temperature @ 700 mA



Input Return Loss @ 400 mA

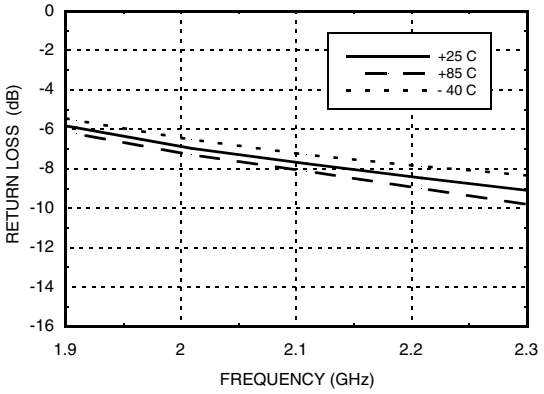


Input Return Loss @ 700 mA

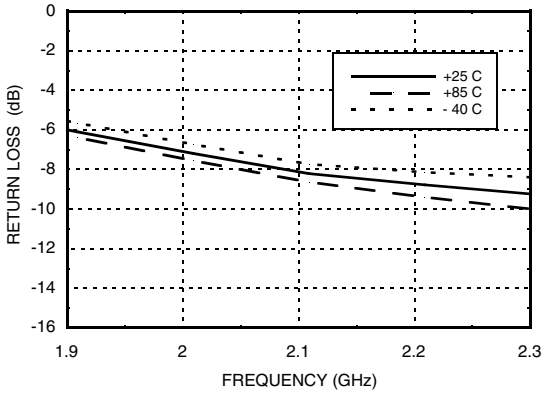


2150 MHz Tune

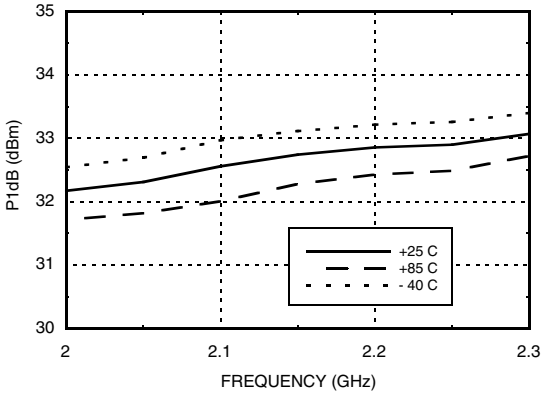
Output Return Loss @ 400 mA



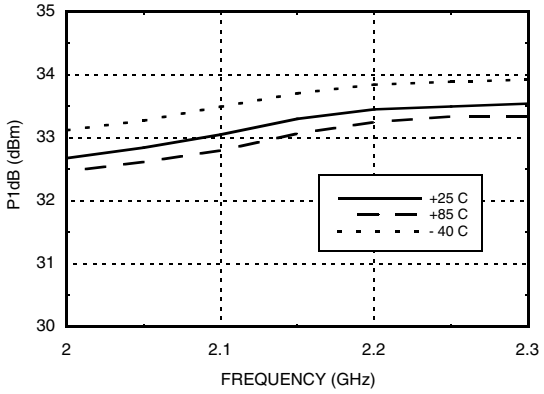
Output Return Loss @ 700 mA



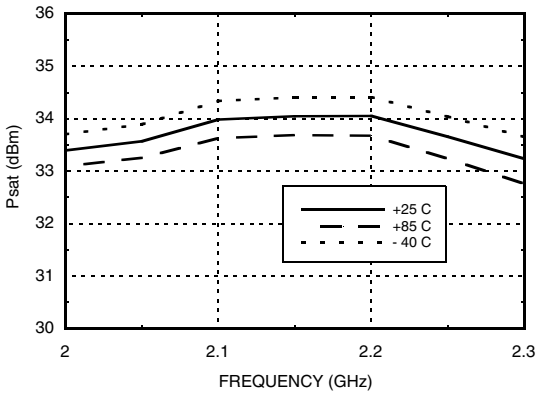
P1dB vs. Temperature @ 400 mA



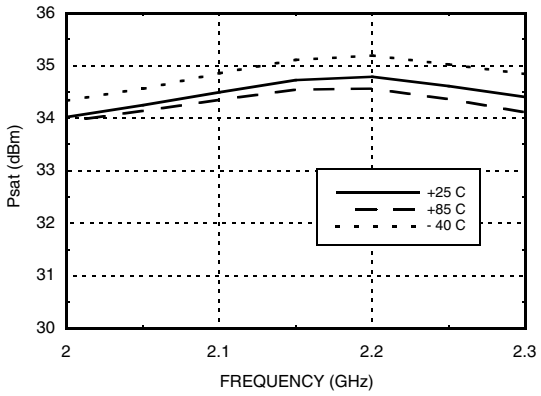
P1dB vs. Temperature @ 700 mA



Psat vs. Temperature @ 400 mA



Psat vs. Temperature @ 700 mA



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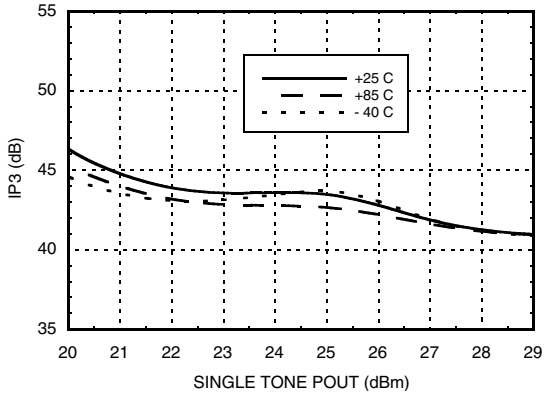
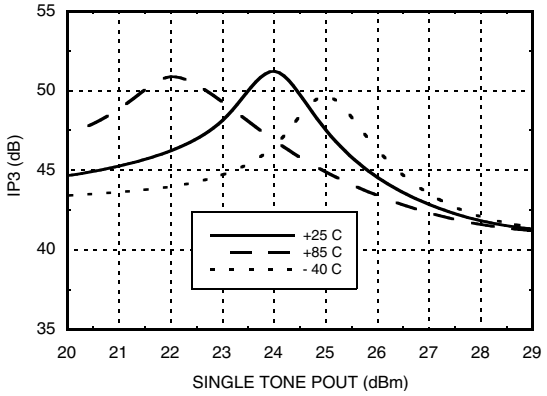
GaAs HBT MMIC 2 WATT POWER AMPLIFIER, 0.4 - 2.7 GHz

2150 MHz Tune

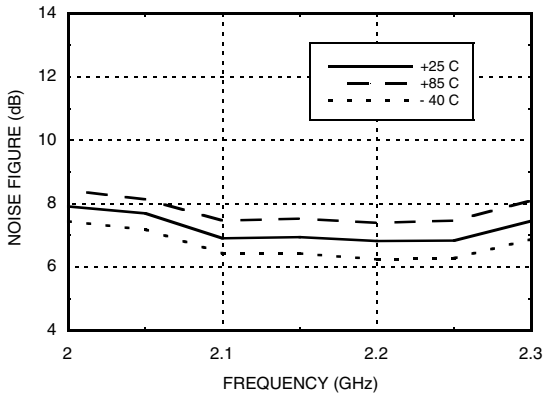
Output IP3 vs Output Power @ 400 mA



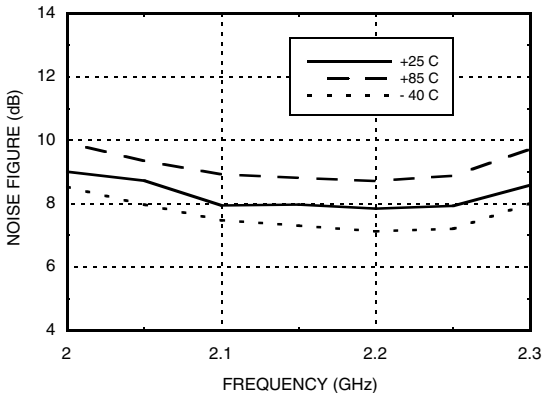
Output IP3 vs Output Power @ 700 mA



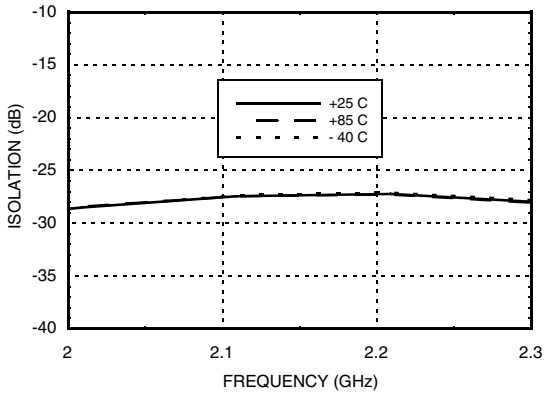
Noise Figure vs. Temperature @ 400 mA



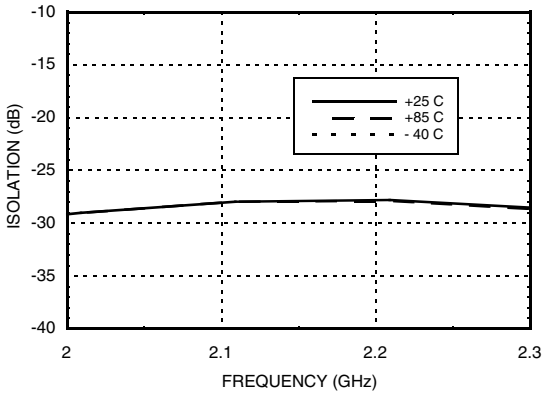
Noise Figure vs. Temperature @ 700 mA



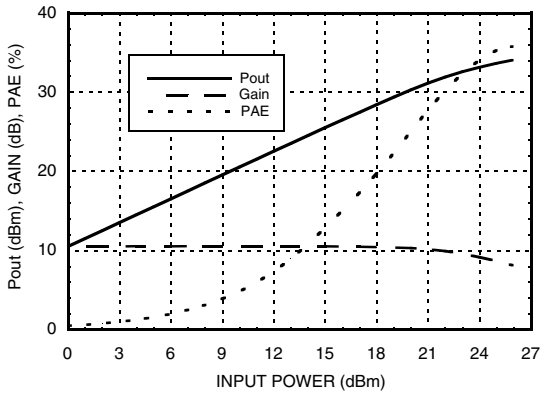
Reverse Isolation vs. Temperature 400 mA



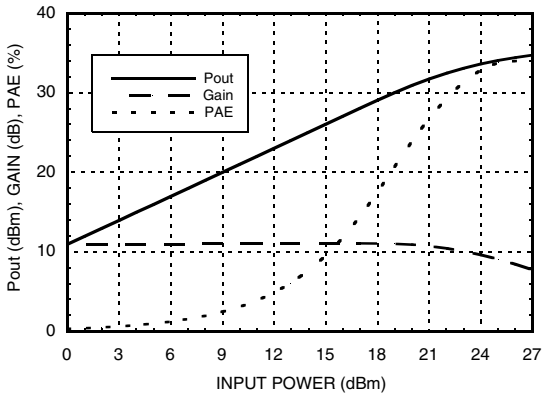
Reverse Isolation vs. Temperature 700 mA



Power Compression @ 400 mA



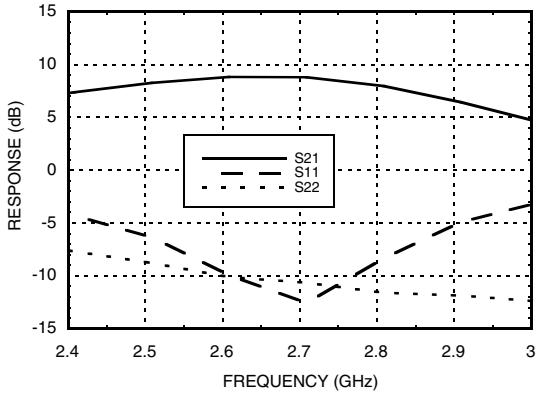
Power Compression @ 700 mA



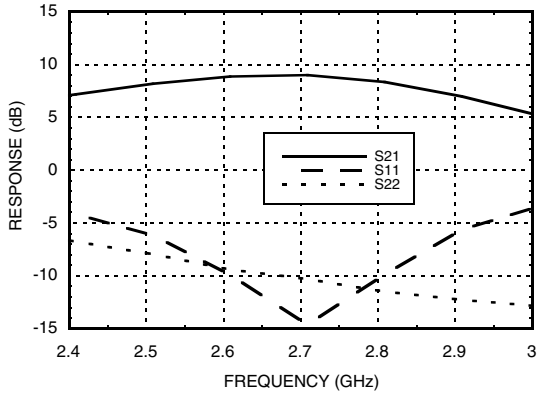
GaAs HBT MMIC 2 WATT POWER AMPLIFIER, 0.4 - 2.7 GHz

2700 MHz Tune

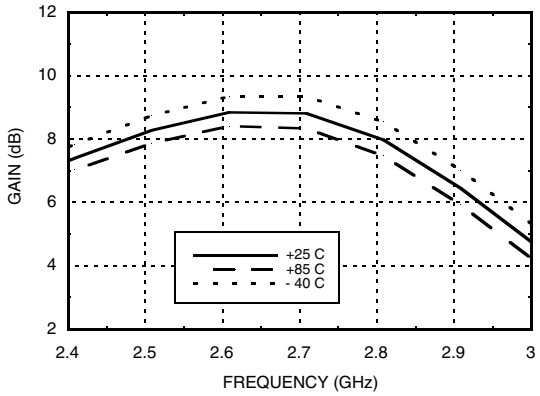
Broadband Gain & Return Loss @ 400 mA



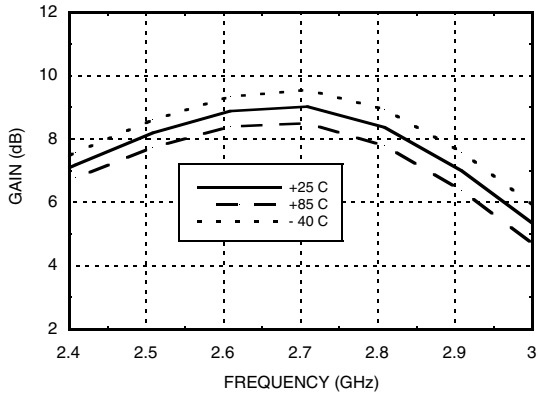
Broadband Gain & Return Loss @ 700 mA



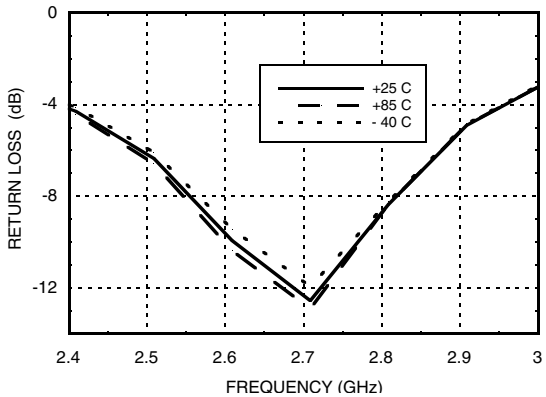
Gain vs. Temperature @ 400 mA



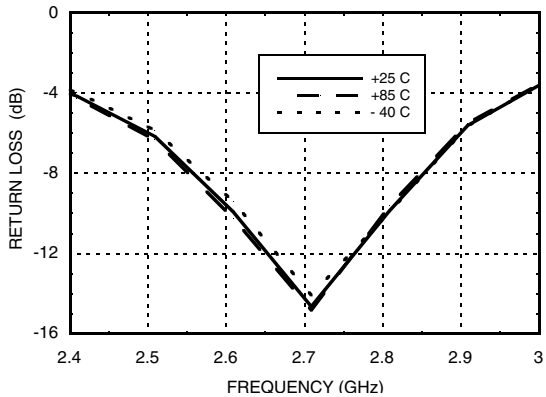
Gain vs. Temperature @ 700 mA



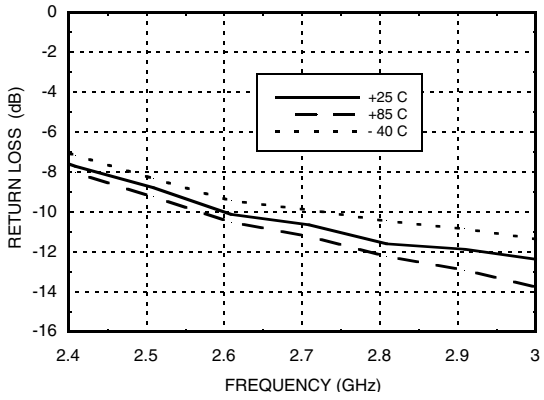
Input Return Loss @ 400 mA



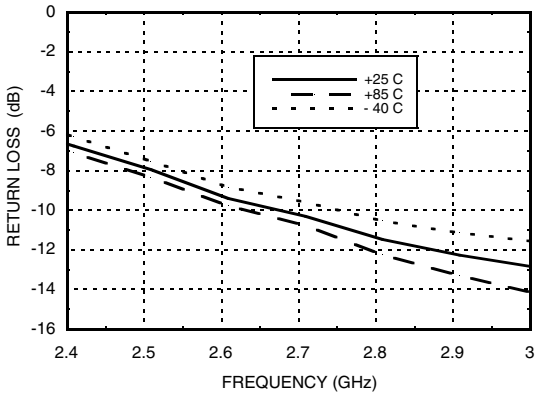
Input Return Loss @ 700 mA



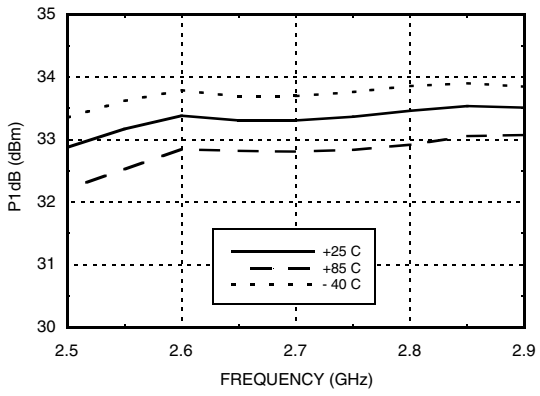
Output Return Loss @ 400 mA



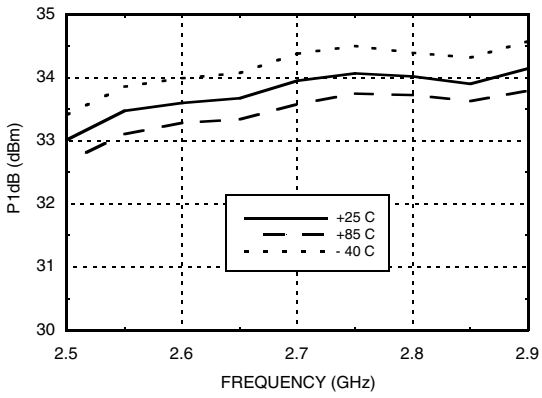
Output Return Loss @ 700 mA



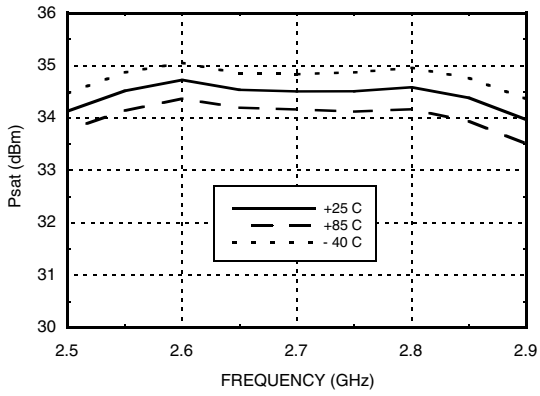
P1dB vs. Temperature @ 400 mA



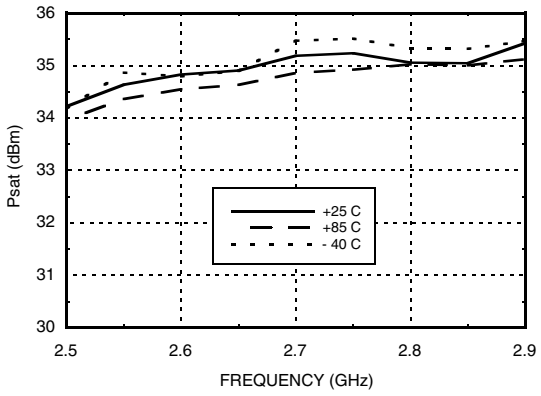
P1dB vs. Temperature @ 700 mA



Psat vs. Temperature @ 400 mA

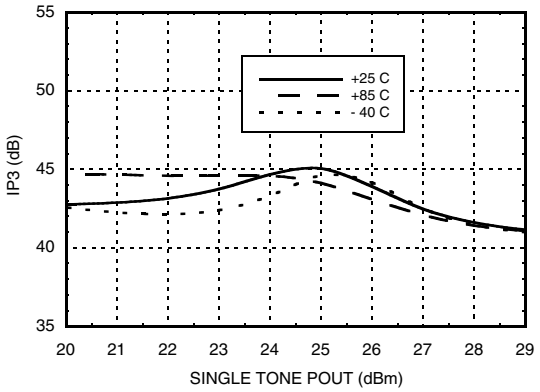


Psat vs. Temperature @ 700 mA

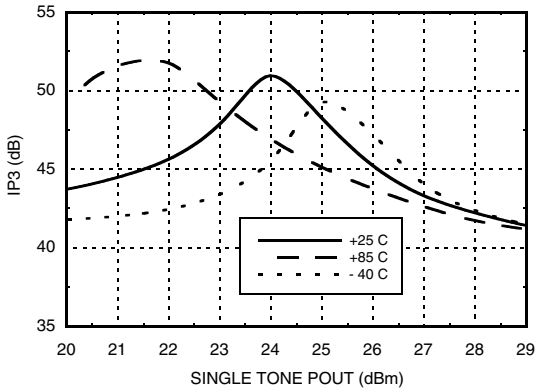


2700 MHz Tune

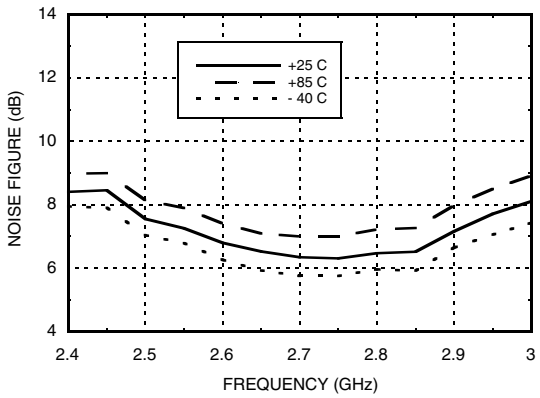
Output IP3 vs. Output Power @ 400 mA



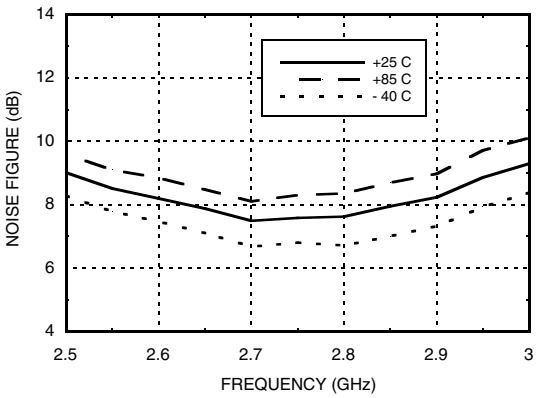
Output IP3 vs. Output Power @ 700 mA



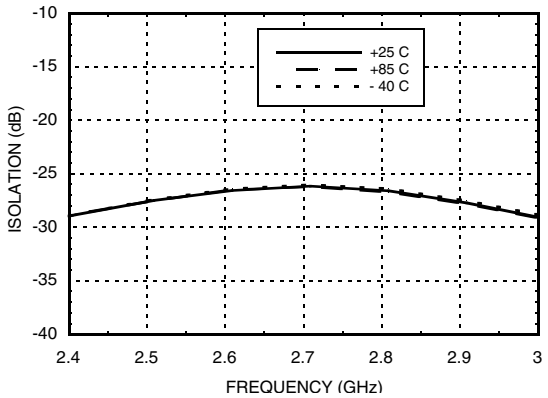
Noise Figure vs. Temperature @ 400 mA



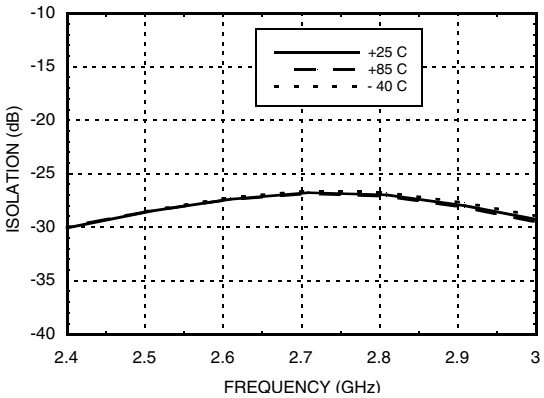
Noise Figure vs. Temperature @ 700 mA



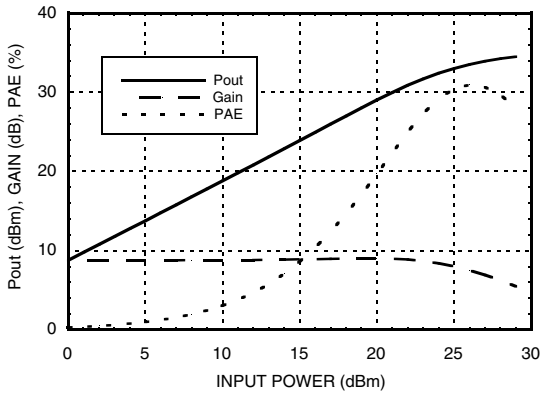
Reverse Isolation vs. Temperature 400 mA



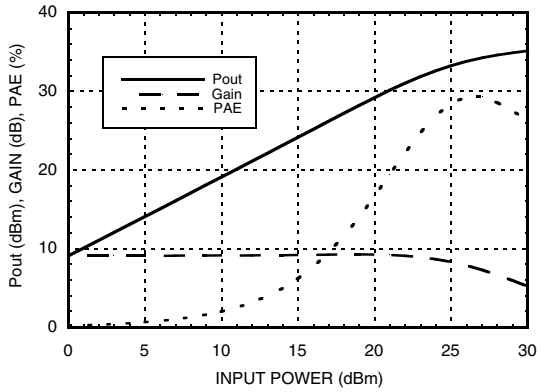
Reverse Isolation vs. Temperature 700 mA



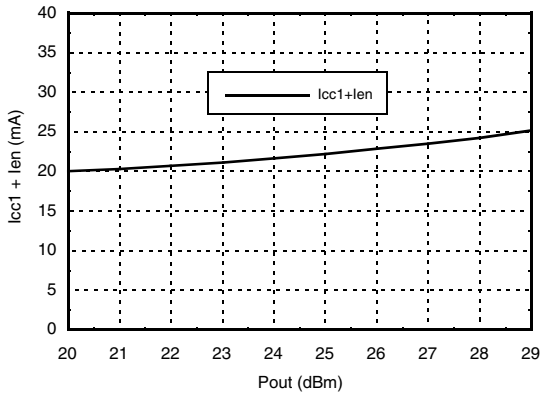
Output IP3 vs. Output Power @ 400 mA



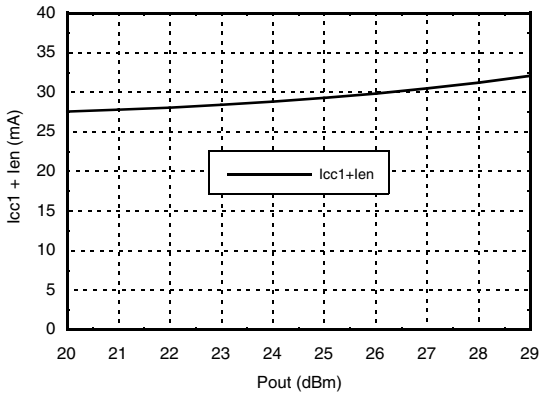
Output IP3 vs. Output Power @ 700 mA



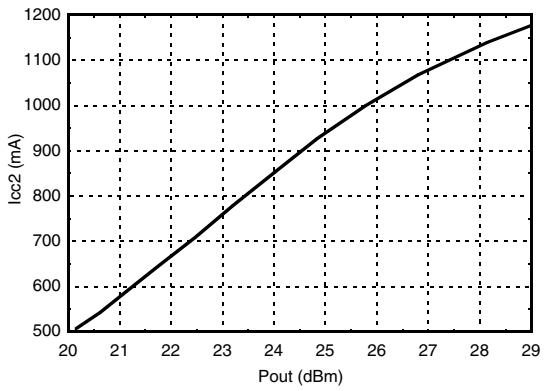
Icc1 + IEN vs. Output Power @ 400 mA



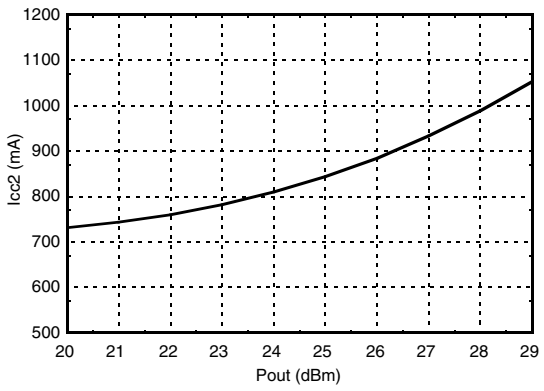
Icc1 + IEN vs. Output Power @ 700 mA



Icc2 vs. Output Power @ 400 mA



Icc2 vs. Output Power @ 700 mA



Absolute Maximum Ratings

Collector Bias Voltage (Vcc1, Vcc2)	+5.5V
RF Input Power (RFIN)	+21 dBm @ 900 MHz +26 dBm @ 1900 MHz
Junction Temperature	150 °C
Continuous Pdiss (T = 85 °C) (derate 67.9 mW/°C above 85 °C)	4.4 W
Thermal Resistance (junction to ground paddle)	14.72 °C/W
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C
ESD Sensitivity (HBM)	Class 1C

ELECTROSTATIC SENSITIVE DEVICE
OBSERVE HANDLING PRECAUTIONS

Recommended Bias Resistor Value

Bias Current vs. R1, Ven = 5V

Vcc1 = Vcc2 (V)	R1 (Ohms)	Ien + Icc1 + Icc2 (mA)
5V	270	420
	225	522
	175	625
	130	715

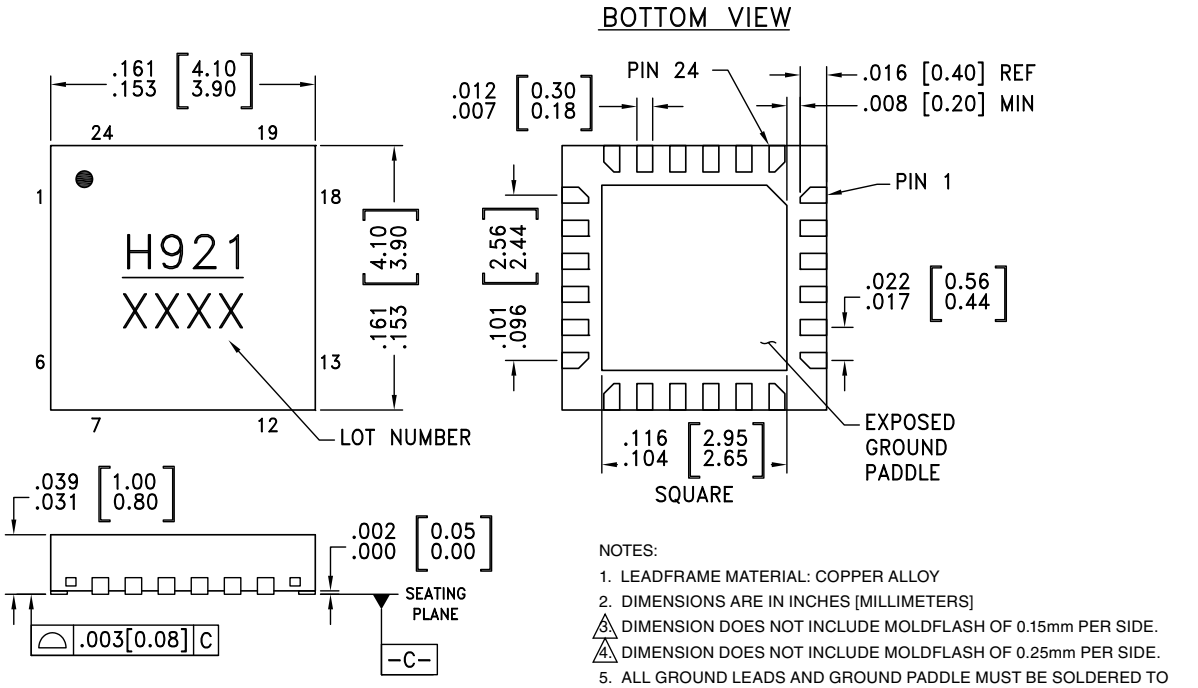
Bias Current vs. R1, Ven = 0V

Vcc1 = Vcc2 (V)	R1 (Ohms)	Ien + Icc1 + Icc2 (mA)
5V	270	2.6
	225	2.6
	175	2.6
	130	2.6

HMC921LP4E

GaAs HBT MMIC 2 WATT POWER AMPLIFIER, 0.4 - 2.7 GHz

Outline Drawing



NOTES:

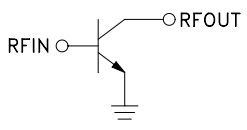
1. LEADFRAME MATERIAL: COPPER ALLOY
2. DIMENSIONS ARE IN INCHES [MILLIMETERS]
3. DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.15mm PER SIDE.
4. DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.25mm PER SIDE.
5. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND.

Package Information

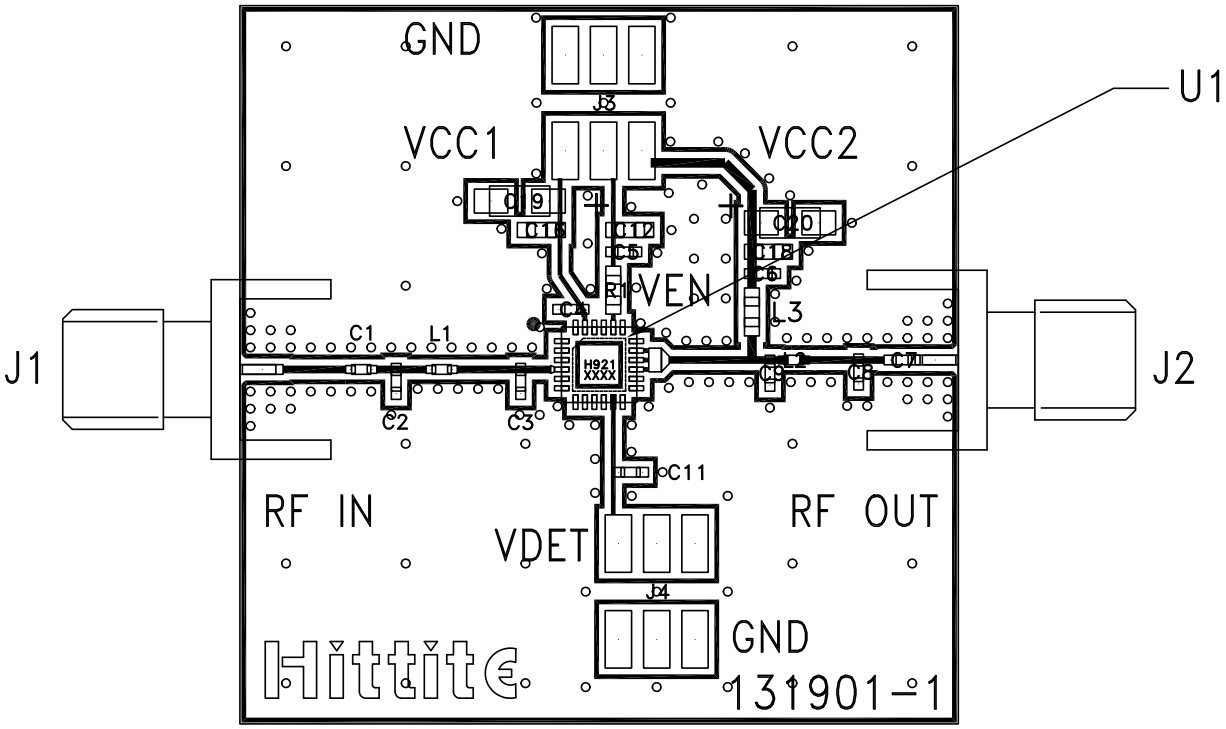
Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking [1]
HMC921LP4E	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL1 [2]	H921 XXXX

[1] 4-Digit lot number XXXX
[2] Max peak reflow temperature of 260 °C

Pin Descriptions

Pin Number	Function	Description	Interface Schematic
1 - 3, 6 - 10, 12 - 14, 18, 19, 21, 22, 24	N/C	The pins are not connected internally; however, all data shown herein was measured with these pins connected to RF/DC ground externally.	
4	RFIN	This pin is DC coupled. Off chip matching components are required. See Application Circuit herein.	
15 - 17	RFOUT / Vcc2	RF output and DC Bias input for the amplifier. Off chip matching components are required. See Application Circuit herein.	
5	GND	These pins & package bottom must be connected to RF/DC ground.	
11	VDET	DC voltage output proportional to RFOUT signal.	
20	VEN	Power control pin. This voltage can be reduced or R1 resistor value increased to reduce quiescent current. For full power down, apply < 0.5V	
23	Vcc1	DC power supply pin for bias circuitry	

450 MHz Evaluation PCB



List of Materials for 450 MHz Evaluation PCB 131903 [1]

Item	Description
J1, J2	SMA Connector
J3, J4	DC Pin
C1, C9	30 pF Capacitor, 0402 Pkg.
C2	15 pF Capacitor, 0402 Pkg.
C3	27 pF Capacitor, 0402 Pkg.
C4 - C6, C11	100 pF Capacitor, 0402 Pkg.
C9, C20	2.2 uF Capacitor, Case A
C12, C16, C18	1000 pF Capacitor, 0402 Pkg.
R1	130 ohms Resistor, 0603 Pkg.
L1	3.6 nH Inductor, 0402 Pkg.
L2	4.7 nH Inductor, 0402 Pkg.
L3	150 nH Inductor, 0603 Pkg.
U1	HMC921LP4E Amplifier
PCB [2]	131901 Evaluation PCB

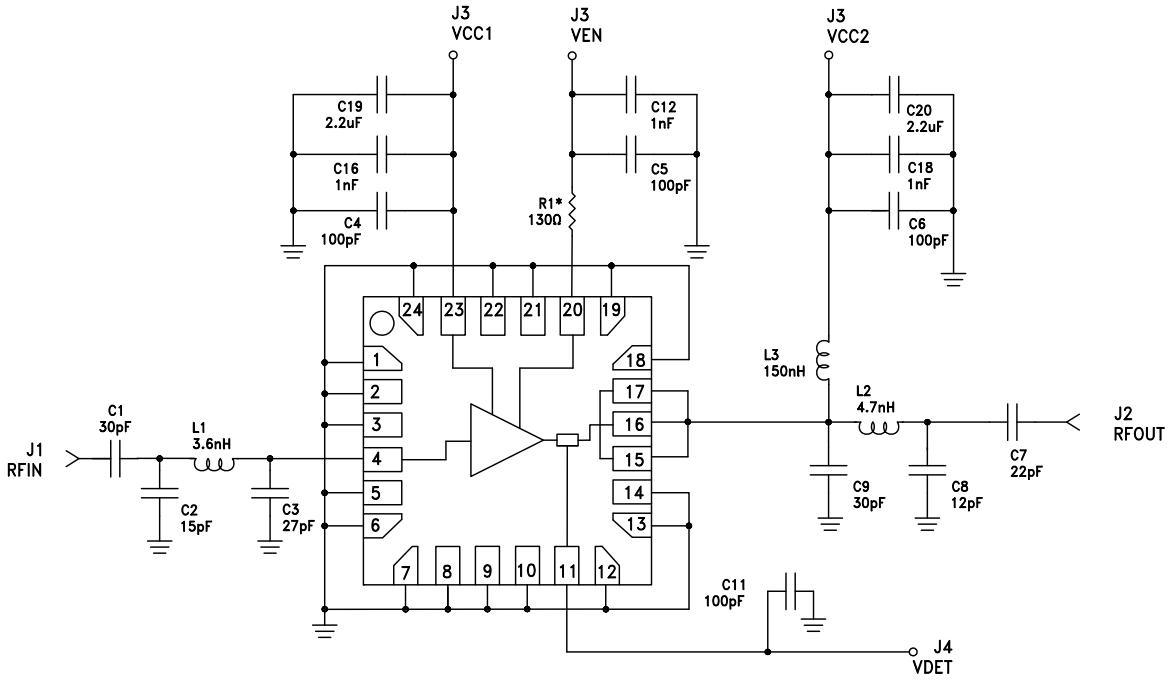
[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350 or Arlon 25 FR

The circuit board used in this application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation board should be mounted to an appropriate heat sink. The evaluation circuit board shown is available from Hittite upon request.

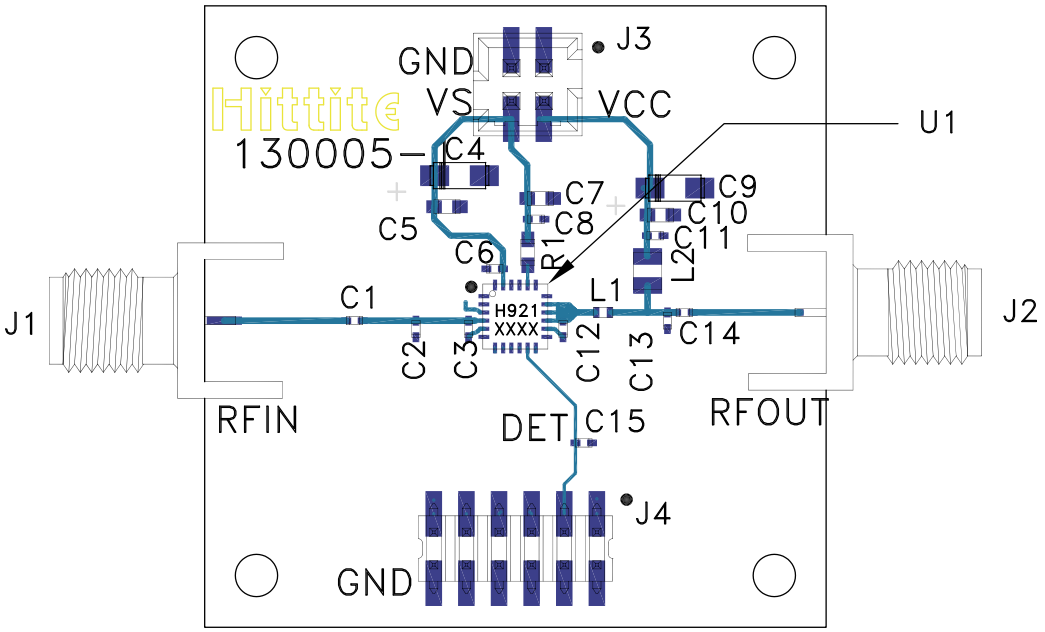
450 MHz Application Circuit

This circuit was used to specify the performance for 350 - 500 MHz operation. Contact the HMC Applications Group for assistance in optimizing performance for your application.



* R1 = 130 Ohms for 700 mA bias, 270 Ohms for 400 mA bias.

900 MHz Evaluation PCB



List of Materials for 900 MHz Evaluation PCB 130007 [1]

Item	Description
J1 - J2	PCB Mount SMA Connector
J3 - J4	2 mm DC Header
C1	22 pF Capacitor, 0402 Pkg.
C2	7.5 pF Capacitor, 0402 Pkg.
C3	5.6 pF Capacitor, 0402 Pkg.
C4, C9	2.2 µF Capacitor, Tantalum
C5, C7, C10	1000 pF Capacitor, 0603 Pkg.
C6, C8, C11, C14, C15	100 pF Capacitor, 0402 Pkg.
C12, C13	8.2 pF Capacitor, 0402 Pkg.
L1	0.78 nH Inductor, 0402 Pkg.
L2	48 nH Inductor, 0402 Pkg.
R1	130 Ohms Resistor, 0603 Pkg.
U1	HMC921LP4E Linear Amplifier
PCB [2]	130005 Evaluation PCB

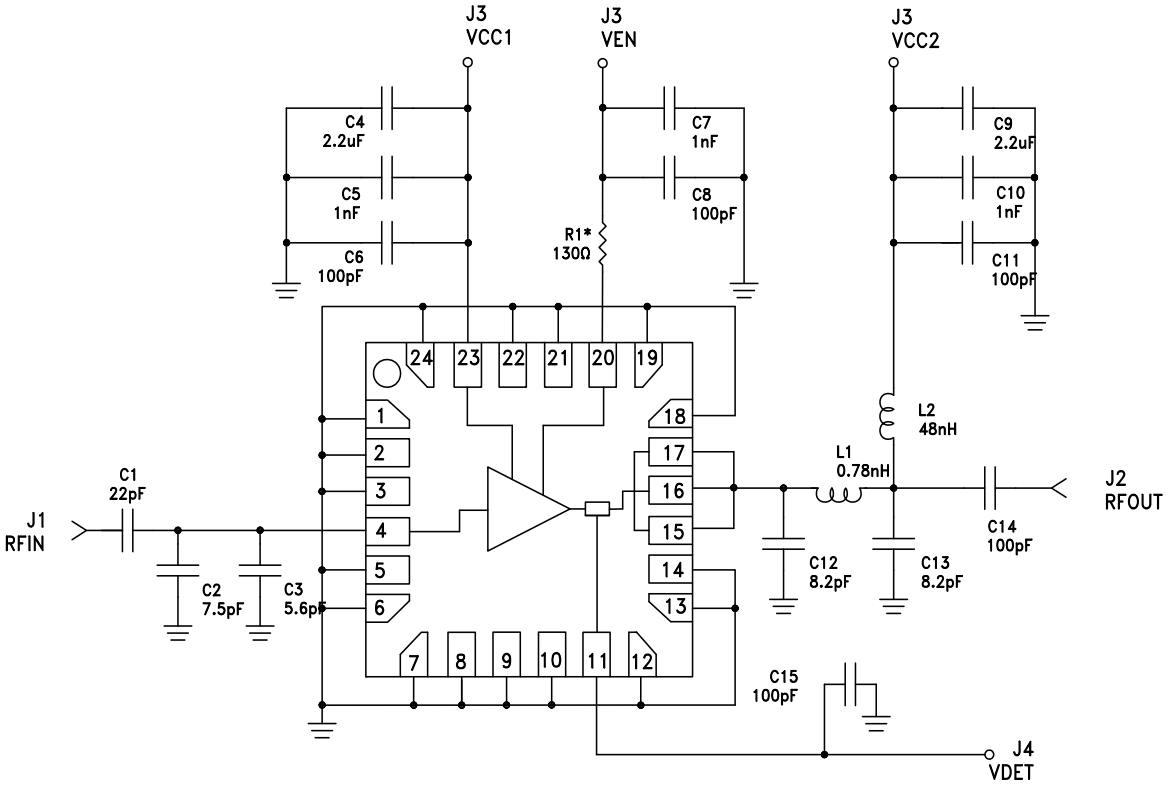
[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350 or Arlon 25 FR

The circuit board used in this application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation board should be mounted to an appropriate heat sink. The evaluation circuit board shown is available from Hittite upon request.

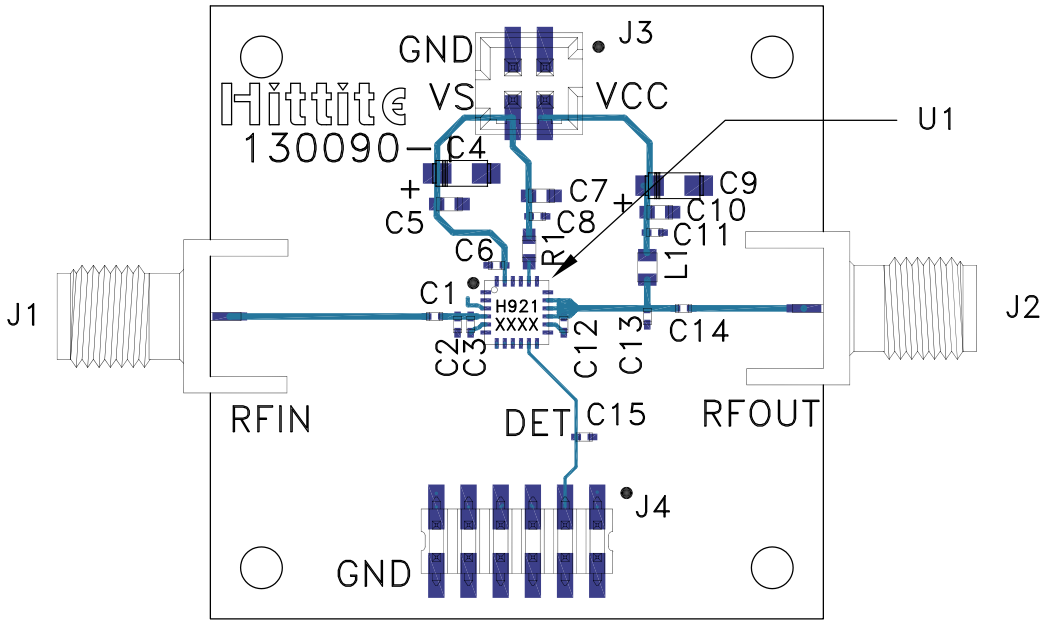
900 MHz Application Circuit

This circuit was used to specify the performance for 800 - 1000 MHz operation. Contact the HMC Applications Group for assistance in optimizing performance for your application.



* R1 = 130 Ohms for 700 mA bias, 270 Ohms for 400 mA bias.

1900 MHz Evaluation PCB



List of Materials for 1900 MHz Evaluation PCB 130008 [1]

Item	Description
J1 - J2	PCB Mount SMA Connector
J3 - J4	2 mm DC Header
C1	0.9 pF Capacitor, 0402 Pkg.
C2	0.9 pF Capacitor, 0402 Pkg.
C3	1.8 pF Capacitor, 0402 Pkg.
C4, C9	2.2 µF Capacitor, Tantalum
C5, C7, C10	1000 pF Capacitor, 0603 Pkg.
C6, C8, C11, C14, C15	100 pF Capacitor, 0402 Pkg.
C12	3.6 pF Capacitor, 0402 Pkg.
C13	2.7 pF Capacitor, 0402 Pkg.
L1	18 nH Inductor, 0402 Pkg.
R1	130 Ohms Resistor, 0603 Pkg.
U1	HMC921LP4E Linear Amplifier
PCB [2]	130090 Evaluation PCB

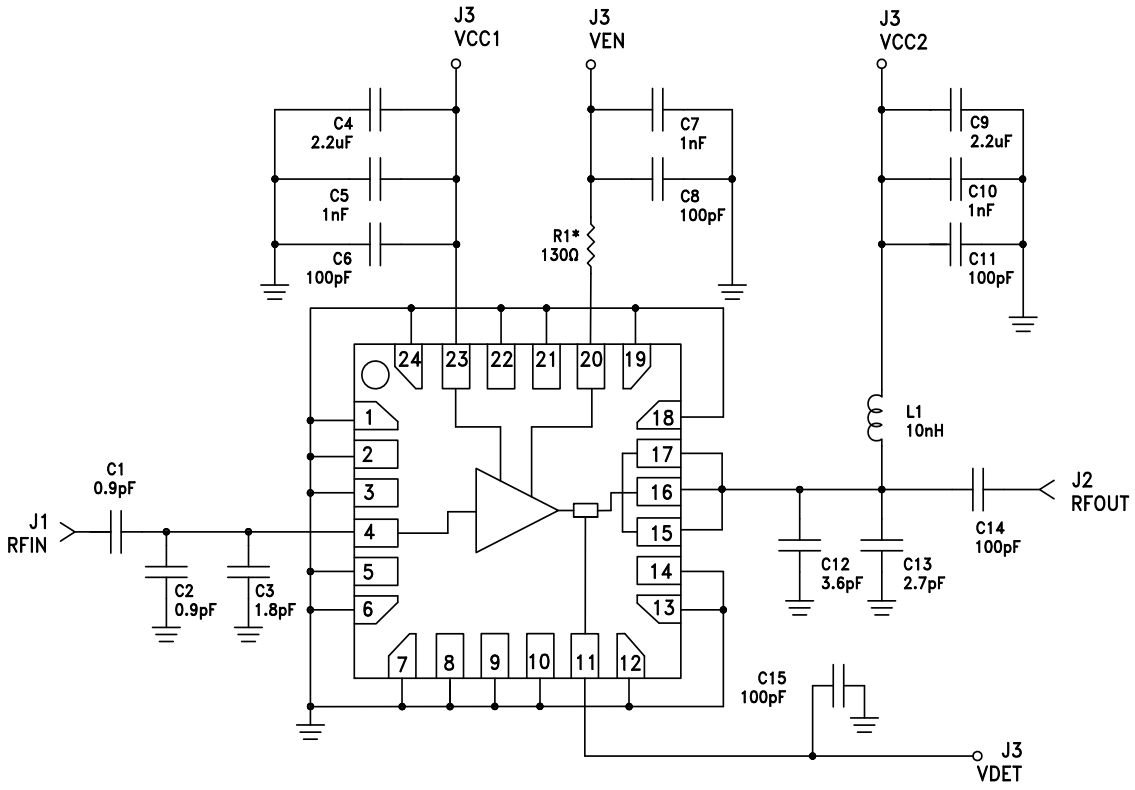
[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350 or Arlon 25FR

The circuit board used in this application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation board should be mounted to an appropriate heat sink. The evaluation circuit board shown is available from Hittite upon request.

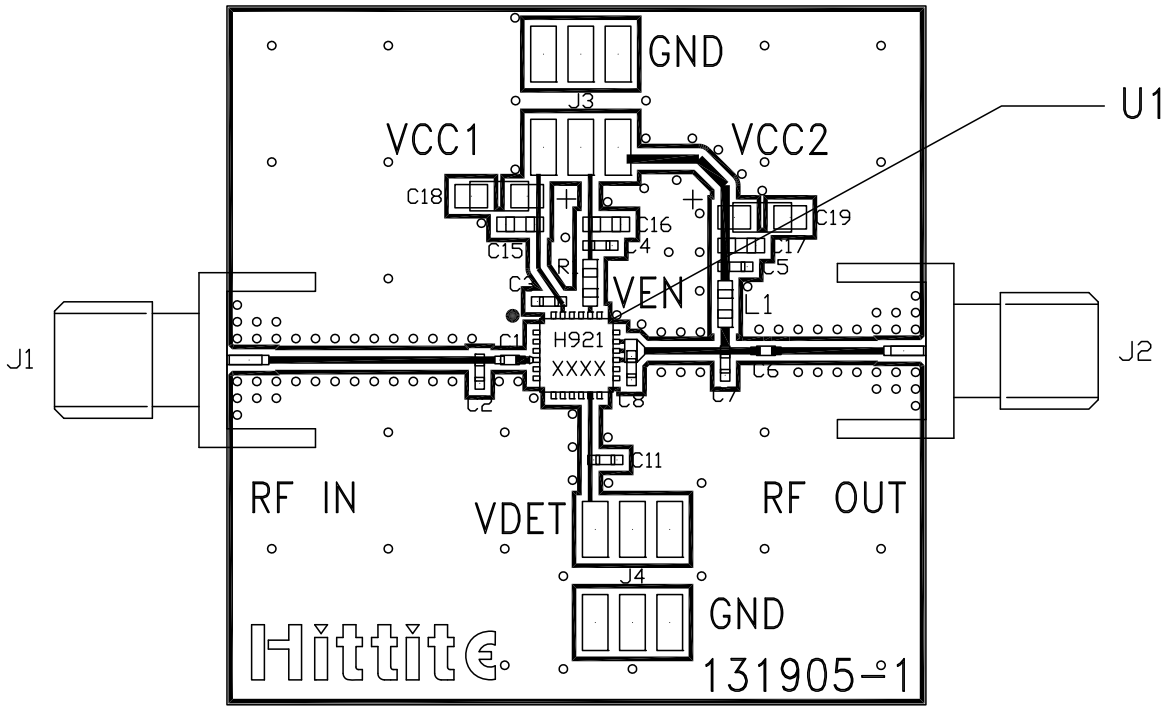
1900 MHz Application Circuit

This circuit was used to specify the performance for 1800 - 2000 MHz operation. Contact the HMC Applications Group for assistance in optimizing performance for your application.



* R1 = 130 Ohms for 700 mA bias, 270 Ohms for 400 mA bias.

2150 MHz Evaluation PCB



List of Materials for 2150 MHz Evaluation PCB 131924 [1]

Item	Description
J1, J2	SMA Connector
J3, J4	DC Pin
C1	3.9 pF Capacitor, 0402 Pkg.
C2, C8	4.3 pF Capacitor, 0402 Pkg.
C7	1.8 pF Capacitor, 0402 Pkg.
C3 - C6, C11	100 pF Capacitor, 0402 Pkg.
C15, C16, C17	1000 pF Capacitor, 0402 Pkg.
C18, C19	2.2 uF Capacitor, Case A.
R1	130 ohms Resistor, 0603 Pkg.
L1	10 nH Inductor, 0603 Pkg.
U1	HMC921LP4E Amplifier
PCB [2]	131905 Evaluation PCB

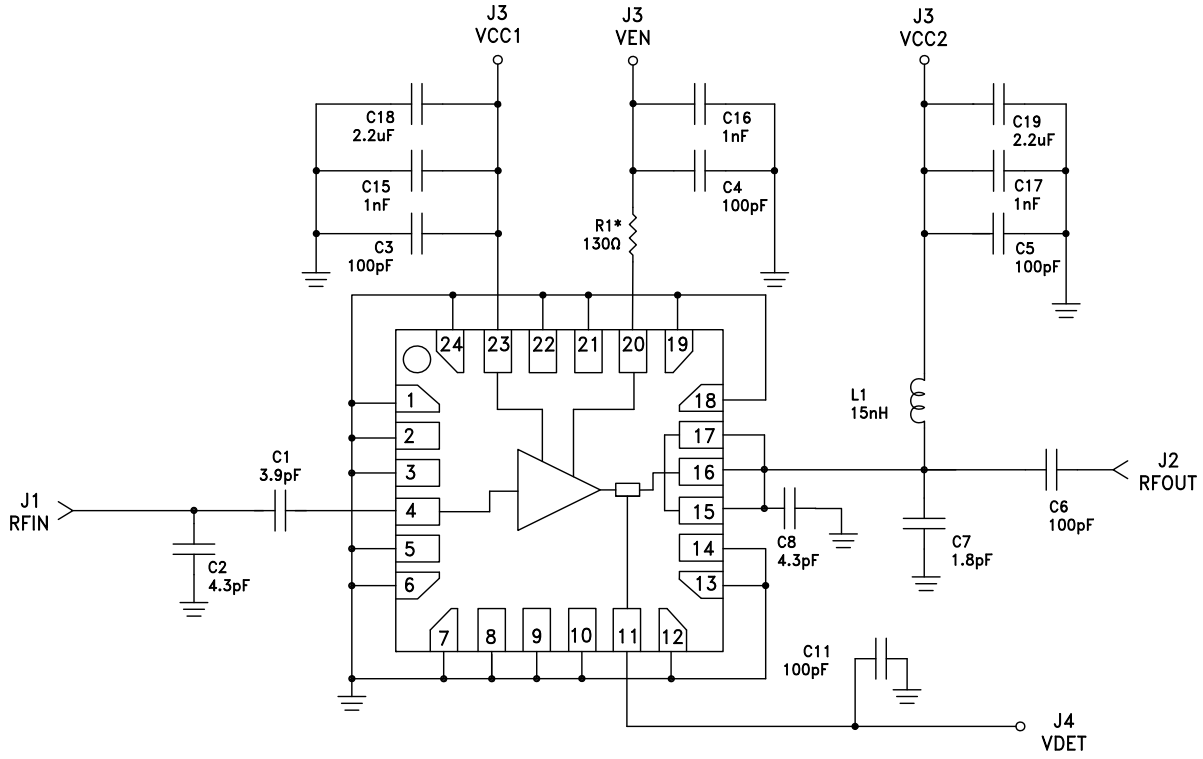
[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350 or Arlon 25 FR

The circuit board used in this application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation board should be mounted to an appropriate heat sink. The evaluation circuit board shown is available from Hittite upon request.

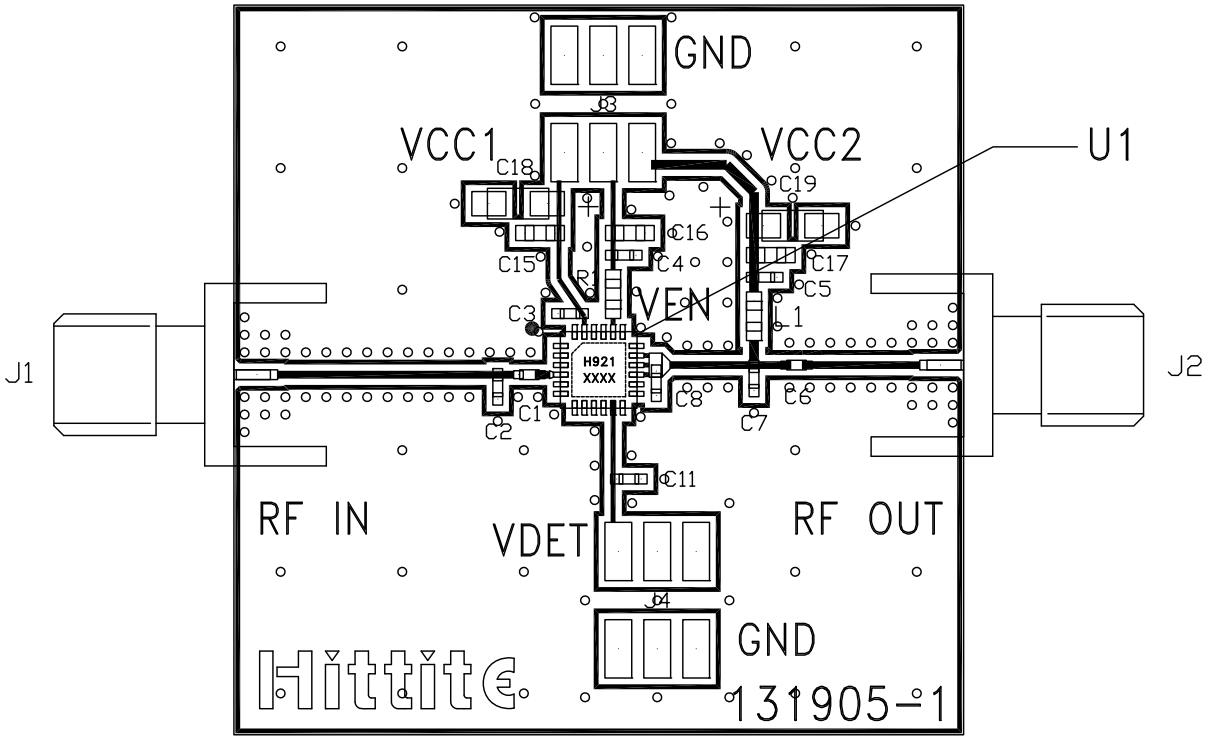
2150 MHz Application Circuit

This circuit was used to specify the performance for 2000 - 2200 MHz operation. Contact the HMC Applications Group for assistance in optimizing performance for your application.



* R1 = 130 Ohms for 700 mA bias, 270 Ohms for 400 mA bias.

2700 MHz Evaluation PCB



List of Materials for 2700 MHz Evaluation PCB 131907 [1]

Item	Description
J1, J2	SMA Connector
J3, J4	DC Pin
C1, C2	2.4 pF Capacitor, 0402 Pkg.
C7	1.3 pF Capacitor, 0402 Pkg.
C3 - C6, C11	100 pF Capacitor, 0402 Pkg.
C15, C16, C17	1000 pF Capacitor, 0402 Pkg.
C18, C19	2.2 uF Capacitor, Case A.
R1	130 ohms Resistor, 0603 Pkg.
L1	10 nH Inductor, 0603 Pkg.
U1	HMC921LP4E Amplifier
PCB [2]	131905 Evaluation PCB

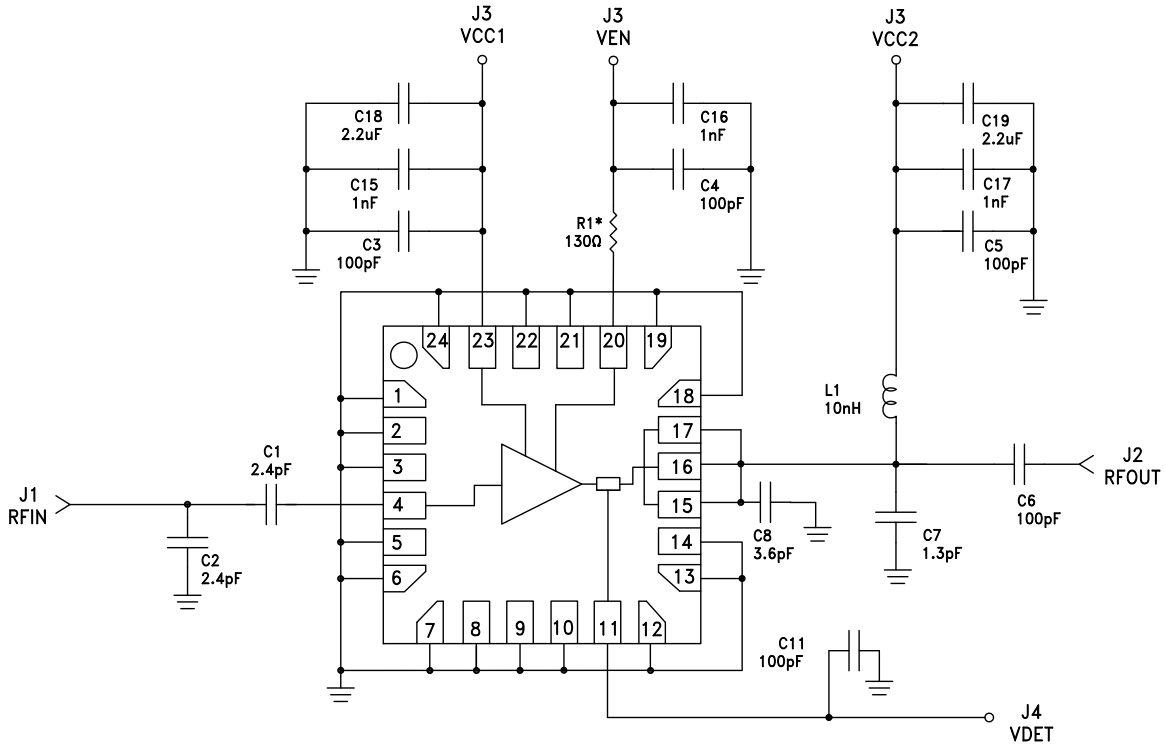
[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350 or Arlon 25 FR

The circuit board used in this application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation board should be mounted to an appropriate heat sink. The evaluation circuit board shown is available from Hittite upon request.

2700 MHz Application Circuit

This circuit was used to specify the performance for 2500 - 2800 MHz operation. Contact the HMC Applications Group for assistance in optimizing performance for your application.



* R1 = 130 Ohms for 700 mA bias, 270 Ohms for 400 mA bias.

Notes:

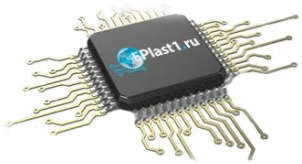
Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits,General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

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Факс: 8 (812) 320-02-42
Электронная почта: org@eplast1.ru
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